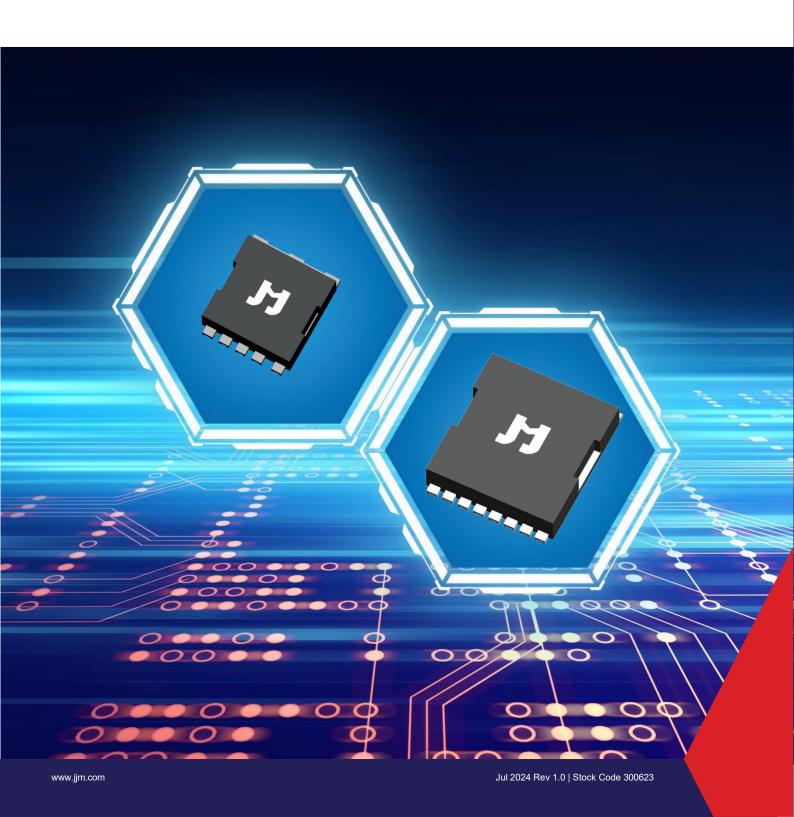


MOSFET Selection Guide



JJMICROELECTRONICS (China)

Qidong

No. 3000, Qiantang River Road, Economic Development Zone, Qidong, Jiangsu

Nantong

No. 6, Jinggangshan Road, Sutong Science and Technology Industrial Park, Nantong, Jiangsu

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••••••

No.1, Jinggangshan Road, Suxitong Park, Nantong, Jiangsu

Shenzhen

Room 4108, Block B1, Building 12, Shenzhen Bay Science and Technology Ecological Park, Shenzhen

Room 1403, Block B, Building 3, Tianyungu Phase I, Bantian Street, Longgang District, Shenzhen

Wuxi

H1-7, China Internet of Things International Innovation Park, No.6, Jingxian Road, Xinwu District, Wuxi

Shanghai

11 / F, Block A, No. 333, Haiyang 1st Road, Lingang Special Area Shanghai Pilot Free Trade Zone

......

Room 1501 & 1502, AFC Great Hongqiao International, No.999, Li'an Road, Xinzhuang Town, Minhang District, Shanghai

.......... JJMICROELECTRONICS (International)

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••••••

Singapore

1 One-north Crescent, Level 7 Singapore 138538

India

Delhi, India

Germany

Stuttgart, Germany

......

JJMICROELECTRONICS

is a leading global IDM for quality power semiconductor devices with almost 30 years of manufacturing excellence.



Key Facts

JJM was established in 1995 and became public listed in 2017. Since then, there has been phenomenal growth, with a CAGR of 30% (2017-2023)



Founded

In 1995 Current Registered Capital USD 105 million* (CNY 736 million)



Revenue

USD 306 million* (CNY 2.1 billion) revenue in 2023



Headquartered

In China, International HQ in Singapore



8 Subsidiaries, 4 Wafer Fabs, 4 A&T sites, 7 R&D teams in 4 R&D centers



Sales Network

Sales representatives & distributors across the globe



Employees

Over 2,000 employees of which 19% are in R&D

*6.8 CNY/USD for 2023

Our Vision is to be an internationally competitive and trusted manufacturer of power semiconductor devices

Our History

The Beginning of Pragmatic Innovation

- JJM established in 1995
- Develop, A/T and sales of Thyristors

Capital Innovation for a Promising Future

- Subsidiary "JieJie Semicon" established for protective components and diodes
- "Power Electronics Eng. Tech Research Center" established

Expansion Of Innovation

- New A/T @QD
- Subsidiary "JJM Shenzhen" & "JJM Shanghai" established

Global Strategic Framework

- Subsidiary "Jiangsu Yixi Tech" established
- Automotive grade A/T kicked off
- GSM International HQ established in SG
- MP started in our
 Nantong new 8" fab

1995 - 2000 • 2001 - 2013

2014 - 2016

† 2017

2018 - 2019

12020

2021 - 2022

2023

Reform & Innovate for Better Product Performance

 Develop, A/T and sale of power components, protective components, diodes, and power modules

A Promising Future

- JJM listed on Shenzhen Stock
 Exchange (Stock code 300623)
- Exchange (Stock code 300623)

 MOSFET R&D center established
- Develop, A/T and sales of MOSFETs

Technology & Quality

- Lab is CNAS accredited
- Subsidiaries "Jiangsu JieJie Semicon", "JJM Wuxi", "JJM Nantong", and "Jiangsu JieJie Semicon Tech Research" established

Expansion of Global Network & Innovation

- GSM International sales established in India and Germany
- Mass production of 6 inch wafer fab @Nantong
- ► Develop, A/T & Sales of IGBTs

3 Main Pillars for Success

In creating values for you, we stand by our pillars of technological innovation, superior quality and competitive agility as keys to customer success and our continued growth to create value for our customers, shareholders, employees and community.







Global Network & Manufacturing Facilities





8 JJM Sales Offices



4 JJM Manufacturing Sites



Solutions for Industry

JJM products are designed and developed to fulfil a diverse array of application requirements across various industries.

Our innovative technologies and commitment to excellence enable faster market entry and improved cost efficiency for our customers.



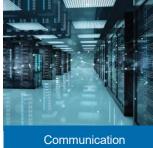
- Clean Energy
- Electrification
- Autonomous Driving



- Sustainable Energy
- ► Industry 4.0
- Automation



- Energy Efficiency
- Digitalization
- Connectivity IoT

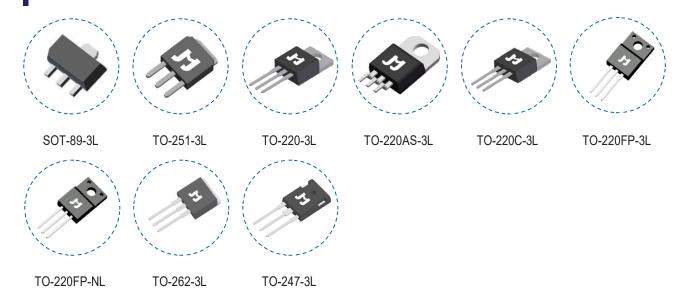


- Mobility
- Cloud Computing
- Artificial Intelligence

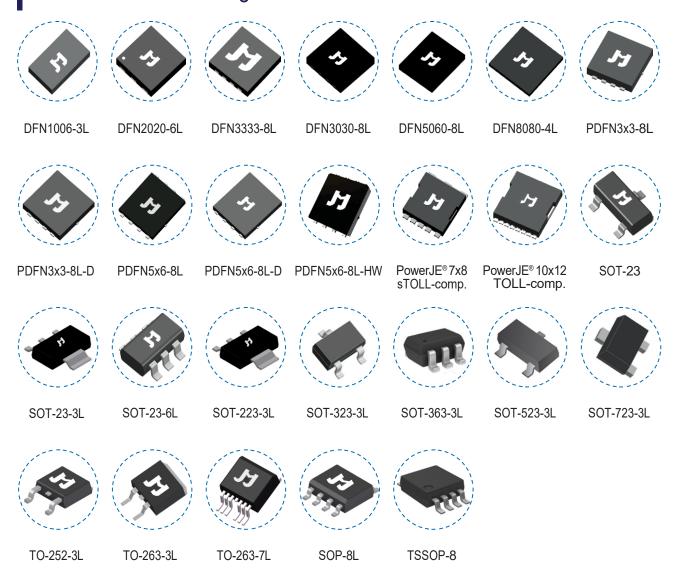


Packages and Nomenclatures	_ 01
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Through-hole Packages



Surface-Mount Packages



Advanced Packaging



TO-263-3L

20% reduction in area 45% reduction in height



PowerJE® 10x12

63% reduction in area45% reduction in height



PowerJE® 7x8



TO-252-3L

Packaging Area	Height	Max Current	Packaging Area	Height	Max Current	Packaging Area	Height	Max Current	Packaging Area	Height	Max Current
150mm ²	4.4mm	195A	120mm ²	2.3mm	360A	56mm ²	2.3mm	260A	60mm ²	2.3mm	100A

48% reduction in area **55%** reduction in height



PDFN5x6-8L



SOP-8L

64% reduction in area **55%** reduction in height



PDFN3x3-8L

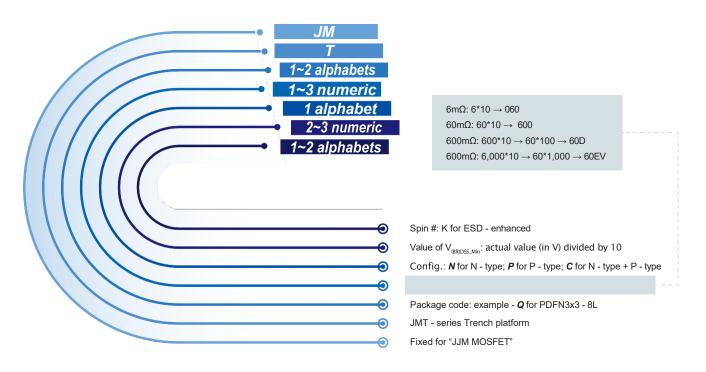
Packaging Area	Height	Max Current	Packaging Area	Height	Max Current	Packaging Area	Height	Max Current
32mm ²	1.0mm	100A	30mm ²	1.75mm	25A	10.8mm ²	1.0mm	195A

Roadmap for Industrial and Automotive Packages

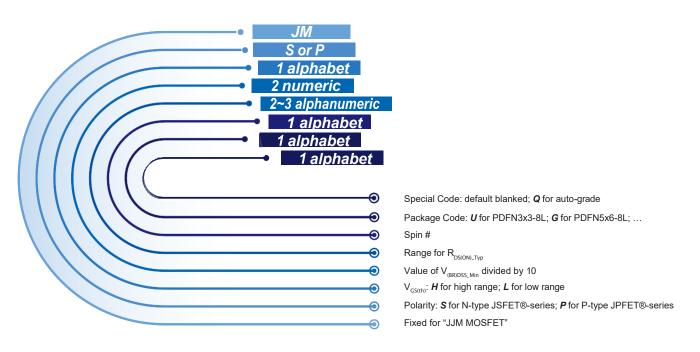


Available Now ~2026

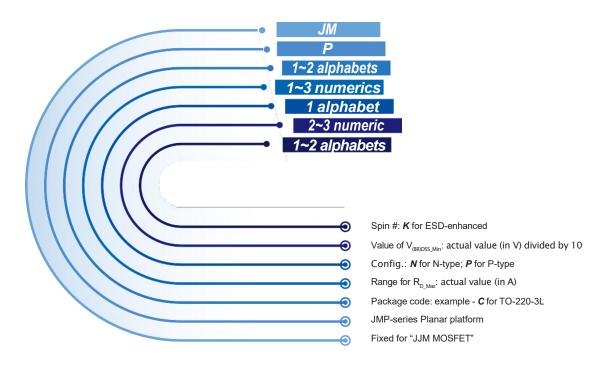
Nomenclature of JMT-series N-ch and P-ch Trench LV/MV MOSFETs



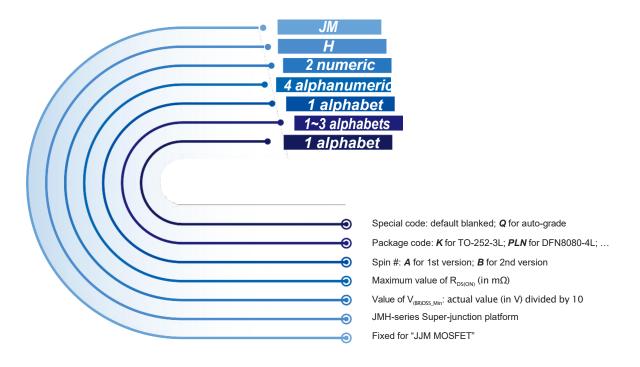
Nomenclature of JSFET® N-ch & JPFET® P-ch SGT LV/MV MOSFETs



Nomenclature of JMP-series N-ch Planar HV MOSFET



Nomenclature of JHFET® Super-junction HV MOSFETs



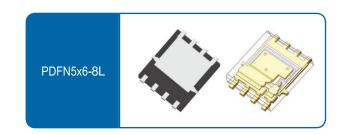
Automotive-grade MOSFETs from JJMicroelectronics (JJM) offer breakdown voltage V_{DS_MIN} from -100V to 650V. The gate-source threshold voltage $V_{GS(th)}$ is at either high-level (2.7 ~ 3.5V) or low-level (1.5 ~ 1.9V, -1.0 ~ -3.0V). Source-Drain turn-ON resistance RDS(ON) is as low as 0.56m Ω (@ V_{GS} = 10V). FOM is low as 55.

These MOSFETs were typically assembled in the highly efficient power packages of either the low-profile surface-mounted type or the legacy through-hole type. These include while not limited to the following packages with excellent thermal characteristics: PDFN3x3-8L, PDFN5x6-8L/-D, PowerJE®10x12 (TOLL-compatible), PowerJE®7x8 (sTOLL-compatible), TO-247-3, etc. All devices were tested for long-term reliability and quality in accordance to the relevant standards defined by AEC Council and JEDEC.

These automotive-grade MOSFETs are widely applied in various pre-installed & after-market sub-systems in automobiles shipped worldwide. These systems and related applications include, but not exclusively, ADAS, infotainment systems, secondary-side (i.e. synchronous DC-DC rectification) of OBC (on-board charger), motor driving in BCM (body control module) and EPS (electronic power steering), electronic relay, load switch, power switch, wireless charging etc.

Single N-channel automotive-grade MOSFETs

PDFN 5x6 SMD Package



R _{dson_max} @V _{gs} =10V / V _{ds}	40V (I _p : 121~400A)	60V (I _p : 147~315A)	100V (I _p : 178A)
0.9mΩ	JMSL040SPGQ		
0.9mΩ	JMSH040SPGQ		
1.0mΩ	JMSH0401PGQ		
1.2mΩ		JMSL0601AGQ	
1.3mΩ		JMSH060SPGQ	
1.6mΩ		JMSL0601BGQ	
1.7mΩ		JMSH0602MGQ	
2.0mΩ	JMSH0402MGQ		
2.3mΩ		JMSL0602AGQ	
2.4mΩ	JMSL0402MGQ	JMSH0603MGQ	
2.8mΩ	JMSH0403RGQ		
2.9mΩ	JMSL0403PGQ		
3.0mΩ		JMSL0603BGQ	
3.3mΩ	JMSH0403PGQ		JMSH1003PGWQ
3.5mΩ			JMSH1003PGQ
4.0mΩ	JMSL04055GQ		
4.3mΩ			JMSH1004BGQ JMSH1003PGWQ
4.5mΩ		JMSL0606PGQ	

R _{dson_max} @V _{gs} =10V / V _{ds}	40V (I _p : 90A)	60V (I _D : 32~112A)	100V (I _p : 27~170A)	150V (I _p : 29~87A)
5.1mΩ		JMSH0606PGQ		
5.4mΩ	JMSH0406PGQ			
5.49mΩ		JMSL06060GQ		
5.9mΩ			JMSL1006PGQ	
9.0mΩ			JMSL1008PGQ	
9.4mΩ		JMSL0608PGQ		
9.6mΩ			JMSH1008PGQ	
9.7mΩ		JMSL0612PGQ		
9.9mΩ				JMSH1509PGQ
11.0mΩ			JMSH1010PGQ	
11.7mΩ			JMSL1010PGQ	
17.1mΩ			JMSL1018PGQ	
19.8mΩ			JMSH1018PGQ	
20.0mΩ		JMSL0620PGQ		
35.0mΩ				JMSH1535PGQ
36.0mΩ			JMSL1040AGQ	

PDFN 3x3 SMD Package



R _{DSON_MAX} @V _{GS} =10V / V _{DS}	40V (I _p : 57~59A)	60V (I _p : 36∼59A)	100V (I _p : 20~76A)
4.81mΩ	JMSL04055UQ		
6.0mΩ	JMSH0406PUQ		
5.2mΩ		JMSL0606PUQ	
9.0mΩ			JMSL1010PUQ
8.7mΩ		JMSL06063UQ	
12.5mΩ		JMSL0612PUQ	
20.0mΩ			JMSL1018PUQ
39.0mΩ			JMSL1040PUQ

DPAK SMD Package



R _{DSON_MAX} @V _{GS} =10V / V _{DS}	40V (I _p : 73~211A)	60V (I _p : 57~206A)	100V (I _p : 45~98A)	150V (I _p : 20~26A)
2.4mΩ	JMSL0402MKQ			
2.5mΩ	JMSH0402AKQ			
2.8mΩ		JMSH0602AKQ		
5.8mΩ		JMSH06060KQ		
5.8mΩ		JMSL0606AKQ		
6.2mΩ	JMSH0406PKQ			
8.1mΩ			JMSL1008PKQ	
8.3mΩ			JMSH1008PKQ	
9.4mΩ		JMSL0608PKQ		
10.0mΩ			JMSL1010PKQ	
11.5mΩ			JMSH1010AKQ	
12.0mΩ		JMSL0612PKQ		
18.8mΩ			JMSL1018PKQ	
65.0mΩ				JMSH1565PKQ
72.0mΩ				JMSH1552PKQ

D2PAK SMD Package



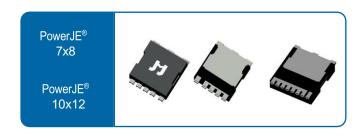
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R _{DSON_MAX} @V _{GS} = 10V / V _{DS}	40V (I _D : 253A)	60V (I _D : 224A)	100V (I _D : 160~350A)	150V (I _D : 71~210A)	650V (I _p : 12~35A)
1.7mΩ	JMSH0402PEQ				
2.0mΩ			JMSH10060EQ JMSH1001NE7Q#		
2.5mΩ		JMSH0602PEQ			
3.5mΩ			JMSH1003PE7Q#		
3.8mΩ			JMSH1003PEQ		
4.2mΩ			JMSH1003PGWQ		
4.9mΩ				JMSH1504PEQ	
6.7mΩ				JMSH1507PEQ	
110.0mΩ					JMH65R110AEFDQ
290.0mΩ					JMH65R290AEFDQ

- Represent D2PAK-7L

Jul 2024 Rev 1.0

PowerJE® SMD package (TO-Leadless compatible)



R _{DSON_MAX} @V _{GS} =10V / V _{DS}	40V (I _D : 295~476A)	60V (I _p : 348A)	100V (I _D : 212~479A)	150V (I _p : 227A)
0.85mΩ	JMSH040SMTLQ			
1.0mΩ	JMSH040SPTLQ			
1.1mΩ	JMSH0401PTSQ#			
1.6mΩ		JMSH0601ATLQ	JMSH1001PTLQ	
2.1mΩ	JMSH0401PTLQ			
3.9mΩ			JMSH1003PTLQ	
4.2mΩ				JMSH1504NTLQ

[#] - $PowerJE^{\otimes}$ 7x8 (sTOLL compatible)

Dual N-channel automotive-grade MOSFETs

PDFN 5x6 SMD package



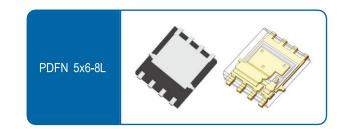
R _{DSON_MAX} @V _{GS} =10V / V _{DS}	40V (I _p : 49 ~50A)	60V (I _p : 23~61A)	100V (I _p : 22~27A)
5.5mΩ		JMSL0606PGDQ	
5.8mΩ		JMSH0606PGDQ	
6.4mΩ	JMSL04060GDQ	,	
6.7mΩ	JMSH0406PGDQ		
10.6mΩ		JMSL0610PGDQ	
10.8mΩ		JMSL0615PGDQ	
20.0mΩ			JMSL1020PGDQ
23.0mΩ		JMSL0620PGDQ	
36.0mΩ			JMSL1040PGDQ

These LV (-30V \leq V_{DS_MIN} \leq 30V) and MV (-100V \leq V_{DS_MIN} \leq 40V, 40V \leq V_{DS_MIN} < 400V) MOSFETs of N-ch or P-ch are designed on either trench or SGT technology platform. While the trench-type MOSFETs generally have higher stamina (i.e. E_{AS}) than the SGT-type MOSFETs at the same die size, the latter would offer lower RDS(ON), Qg and Ciss hence lower conduction and switching losses.

For consumer electronics (fast chargers, FPTVs, personal audio, home appliances, gaming & toys, personal computing, power tools, automobiles, etc.), networking equipment (router, multi-port switches, web / storage / security servers, etc.), communication equipment (4G/5G base stations, BBU, RRUs, AAUs, etc.), industrial equipment (robotics, factory, industrial PCs, energy storage system, solar/wind/hydro power generation, farming, public transportation, etc.), JJM offers the following low/mid-voltage MOSFETs to meet the diverse needs of system designers.

Single N-channel industrial-grade MOSFETs

PDFN 5x6 SMD Package



R _{dson_max} @V _{gs} =10V / V _{ds}	30V (I _D : 80~327A)	40V (I _p : 100~400A)	60V (I _D : 142~303A)	100V (I _p : 135~144A)
0.69mΩ	JMSL030STG			
0.75mΩ		JMSL040SPG		
0.9mΩ		JMSH040SPG		
1.0mΩ		JMSL0401PG		
1.1mΩ	JMSL0301TG	JMSH0401PG		
1.3mΩ			JMSH0601TG	
1.5mΩ			JMSL0602MG	
1.8mΩ	JMSL0302PG	JMTG016N04A JMSL0401TG JMSH0402PG	JMSL0601TG	
1.9mΩ	JMTG018N03A		JMSH0602PG	
2.2mΩ	JMSL0303TG JMTG3002B			
2.8mΩ			JMSH0602AG	
2.5mΩ		JMSL0402BG	JMSL0602AG	
2.8mΩ			JMSH0403RG	
2.9mΩ		JMSL0402TG JMTG035N04L	JMSL0603PG	
3.1mΩ	JMTG3003A		JMSL0603BG	
3.4mΩ	JMTG040N03A	JMSH0403TG		
3.7mΩ		JMTG4004A JMTG035N04A		JMSH1003NG
3.9 mΩ		JMSL0403PG		

R _{DSON_MAX} @ V _{GS} =10V/V _{DS}	30V (I _D : 30~65A)	40V (I _D : 40~86A)	60V (I _p : 25~114A)	100V (I _D : 18.9~117A)	120V (I _p : 94A)	150V (I _D : 11.6~77A)
4.2mΩ		JMTG055N04A	JMSL0606PG JMTG060N06A			
4.8mΩ	JMSL0307PG			JMSH1004NG		
4.9mΩ	JMTG3005A		JMSH0606AG			
5.1mΩ		JMSH0406PG				
5.4mΩ				JMSL1004RG		
$5.7 m\Omega$				JMSL1005PG		
5.8mΩ	JMTG3005A		JMSH0606PG JMTG070N06A			
6.4mΩ				JMSL1009PG JMSH1006PG		
$6.5 \text{m}\Omega$				JMSH1008PG		
7.0mΩ					JMSH1207PG	
7.7mΩ				JMSL1010PG		
7.9mΩ		JMTG60N04B				
8.0 mΩ				JMSL0608PG JMTG100N06A		
8.6mΩ	JMTG3008A					
8.8mΩ	JMSL0315PG					
9.5mΩ				JMSH1010PG		
9.8mΩ	JMTG100N03A					
9.9mΩ						JMSH1509PG
10.9mΩ		JMTG100N04A				JMSH1510PG
11.8mΩ			JMSL0611PG			
12.6mΩ						JMSH1509PG
13.0mΩ						JMSH1516PG
15.0mΩ			JMTG170N06A			
16.7mΩ				JMSL1018PG		
16.8mΩ						JMSH1516PG
19.0 mΩ				JMSH1018PG		
20.0 mΩ			JMSL0620PG			
28.0 mΩ			JMSL0630PG			
30.0 mΩ				JMTG320N10A		
35.0 mΩ						JMSH1535PG
31.0 mΩ				JMSL10380G		
$52.0~\text{m}\Omega$						JMSH1552PG

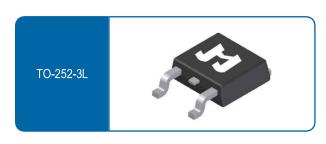
PDFN 3x3 SMD Package



R _{DSON_MAX} @ V _{GS} =10V / V _{DS}	20V (I _D : 50~80A)	30V (I _p : 12~145A)	40V (I _D : 30~119A)	60V (I _D : 19.8~69 A)	100V (I _D : 10~67A)	150V (I _p : 14~15A)
1.5mΩ		JMSL0302PU				
1.9mΩ		JMSL0302PU				
2.2mΩ		JMSL0303TU				
2.5mΩ			JMSL0402TU			
2.7mΩ*	JMTQ025N02A					
3.1mΩ			JMSL0403PU			
$3.4 \text{m}\Omega$		JMTQ3003A				
3.9mΩ*	JMTQ90N02A					
4.0mΩ		JMTQ040N03A				
4.7mΩ				JMSL0606PU		
4.8mΩ		JMTQ3005A				
4.9mΩ*	JMTQ050N02A					
5.0mΩ		JMSL0310PU				
5.4mΩ			JMSH0406PU			
5.5mΩ				JMSH0606PU		
5.6mΩ			JMSL0406PU JMTQ055N04A			
6.1mΩ		JMTQ3006B				
6.6mΩ			JMTQ062N04A			
8.1mΩ				JMSL068PU		
8.6mΩ		JMTQ3008A	JMTQ60N04B			
9.0mΩ		JMTQ100N03A JMSL0315PU			JMSL1010PU	
10.0mΩ			JMTQ100N04A			
11.7mΩ				JMSL0611PU		
11.8mΩ		JMTQ120N03A				
15.0mΩ				JMTQ35N06A		
19.4mΩ		JMTQ240N03A				
20.0mΩ				JMSL0620PU		
27.0mΩ				JMSL0630PU		
32.0mΩ					JMTQ320N10A	
36.0mΩ					JMSL10380U	
52.0mΩ						JMSH1552AU
120.0mΩ					JMTQ11DN10A	

^{* -} $R_{\rm DSON_MAX}$ based on $V_{\rm GS}$ =4.5V

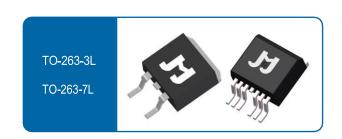
DPAK SMD Package



R _{DSON_MAX} @V _{GS} =10V / V _{DS}	20V (I _D : 20~190A)	30V (I _D : 20~190A)	40V (I _D : 60~150A)	60V (I _D : 30~195A)	100V (I _p : 30~99A)
2.2mΩ		JMSL0302PK	JMSL0402PK		
2.6mΩ		JMTK3002B JMTK018N03A			
2.8mΩ				JMSH0602PK	
3.4mΩ		JMTK3003A			
3.5mΩ		JMSL0303AK			
3.6mΩ	JMTK90N02A	JMTK3004A			
3.7mΩ				JMSL0603PK JMSH0603PK	
3.8mΩ			JMTK035N04L		
4.0mΩ		JMTK3005L			
4.3mΩ			JMTK4004A		
4.4mΩ		JMTK3005A			
4.9mΩ	JMTK75N02A		JMTK4005A		
5.4mΩ			JMSL0406PK		
5.5mΩ				JMSH0606PK	
5.8mΩ				JMSL0606PK	
5.9mΩ			JMTK4006A	JMTK060N06A	
6.0mΩ		JMTK3006B			
6.2mΩ	JMTK2006A		JMSH0406AK		
6.9mΩ	JMTK2007A				JMSL1009PK
7.0mΩ			JMTK60N04B		
7.6mΩ				JMTK80N06A	JMSL1005PK JMSH1006PK
8.4mΩ		JMTK100N03A		JMTK58N06B JMTK110N06A	JMSL1010PK
8.6mΩ		JMTK50N03A			
8.8mΩ				JMSL0608PK	
10.4mΩ	JMTK100N02A				
11.5mΩ					JMSH1010AK
11.8mΩ		JMSL0315PK			
12.0mΩ				JMSL0612PK	
12.2mΩ		JMTK120N03A			
15.0mΩ				JMTK50N06B	
17.4mΩ					JMSL1018PK
20.0mΩ					JMTK170N10A
29.0mΩ				JMTK290N06A	
30.0mΩ					JMTK320N10A

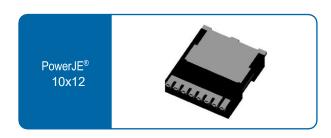
R _{DSON_MAX} @V _{GS} =10V / V _{DS}	60V (I _p : 15~20A)	100V (I _D : 9~24A)	150V (I _p : 18~20A)
33.0mΩ	JMTK330N06A		
39.0mΩ		JMSL10380K	
48.0mΩ		JMTK500N10A	
49.0mΩ	JMTK480N06A		
52.0mΩ			JMSH1552PK
70.0mΩ		JMSL1070PK	
108.0mΩ		JMTK10N10A	
138.0mΩ		JMSL10130PK	

D2PAK SMD Package



R _{DSON_MAX} @V _{GS} =10V / V _{DS}	30V (I _p : 150~190A)	40V (I _p : 150~190A)	60V (I _p : 115~195A)	100V (I _p : 95~290A)	150V (I _p : 115~205A)
1.9mΩ				JMSH1001NE JMSH1001NE7#	
2.3mΩ	JMTE018N03A				
2.5mΩ			JMSH0602PE		
2.8mΩ	JMTE3002B	JMTE025N04D		JMSH1002NE	
3.7mΩ	JMTE3003A			JMSH1002YE	
3.6mΩ				JMSH1003NE	
3.8mΩ			JMTE035N06D		
4.0mΩ		JMTE035N04A			
4.8mΩ				JMSH1004NE	
4.5mΩ					JMSH1504NE
3.7mΩ					JMSH1504NE7#
4.5mΩ					JMSH1504NE
5mΩ				JMSH1005PE	
6.0mΩ			JMTE060N06A		JMSH1507PE JMSH1507PE7#
6.3mΩ			JMSL0606PE		
6.4mΩ				JMSH1006PE	
7.8mΩ				JMSL1009PE	
8.0mΩ				JMSH1008PE	

PowerJE® SMD package



R _{DSON_MAX} @V _{GS} = 10V / V _{DS}	40V (I _D : 310~474A)	80V (I _p : 229~285A)	100V (I _D : 200~325A)	150V (I _D : 159~263A)	200V (I _p : 119A)
1.0mΩ	JMSH0401PTL				
1.3mΩ	JMSL0402PTL				
1.6mΩ			JVL101N		
1.8mΩ		JMSH0802PTL			
2.0mΩ		JMSH0802MTL			
2.3mΩ			JVL102T		
2.6mΩ			JVL102E		
2.9mΩ		JBL083M			
3.4mΩ			JVL102Y		
3.9mΩ				JMSH1504NTL	
5.8mΩ				JMSH1507PTL	
8.6mΩ					JMSH2010PTL

DFN-2020 SMD package

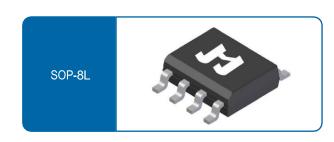


R _{dson_max} @V _{gs} = 10V / V _{ds}	20V (I _p : 10~25A)	30V (I _p : 12~29A)
4.8mΩ		JMSL0307PV
6.6mΩ*	JMTV070N02A	
8.1mΩ		JMTV075N03A
9.0mΩ	JMTV080N02A	JMSL0315PV
9.8mΩ*	JMTV100N02A	
10.0mΩ		JMTV3010A
12.0mΩ		JMTV120N03A

^{* -} R_{DSON_MAX} based on V_{GS} =4.5V (continued)

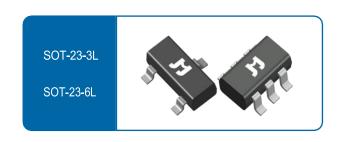
R _{DSON_MAX} @V _{GS} = 10V / V _{DS}	30V (I _o : 8~10A)	60V (I _p : 21A)	100V (l _p : 4.7A)
12.8mΩ		JMSL0615PV	
20.3mΩ	JMTV240N03A		
23.0mΩ	JMTV3400A		
36.0mΩ			JMSL10380V

SOP-8 SMD package



R _{DSON_MAX} @V _{GS} = 10V / V _{DS}	30V (I _D : 4.5~20A)	40V (I _D : 6~17.8A)	60V (I _D : 10~17A)	100V (I _p : 2.4~12.3A)	150V (I _D : 4.1~4.6A)
6.0mΩ	JMTP045N03A	JMSL0406PP			
6.4mΩ			JMSL0606PP		
8.0mΩ	JMTP3008A				
9.0mΩ		JMTP080N04A	JMTP075N06A		
10.0mΩ	JMSL0315PP				
10.3mΩ			JMSL0608PP		
11.1mΩ				JMSL1010PP	
12.0mΩ	JMTP4406A		JMTP110N06A		
11.8mΩ			JMSL0611PP		
14.3mΩ		JMTP130N04A			
15.9mΩ			JMTP170N06A		
19.8mΩ				JMSL1018PP	
36.0mΩ	JMTP380N03D				
37.0mΩ		JMTP400N04A			
40.0mΩ				JMSL10380PD	
52.0mΩ					JMSH1552PP
70.0mΩ				JMSL1070PPD	
115.0mΩ				JMTP11DN10A	
134.0mΩ				JMSL10130PP	

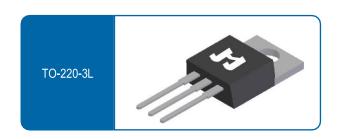
SOT-23 SMD package



R _{DSON_MAX} @V _{GS} = 10V / V _{DS}	20V (I _p : 0.9~8A)	30V (I _p : 4~5.8A)	40V (I _D : 5~8A)	60V (I _p : 0.3~3A)	100V (I _p : 1.8~3A)
14.0mΩ*	JMTJ100N02A				
21.0mΩ*	JMTL2312A				
22.0mΩ	JMTL3416KS		JMTM170N04A#		
25.0mΩ		JMTL3404A			
26.0mΩ		JMTL3400A			
26.7mΩ		JMTJ3400A			
29.0mΩ*	JMTL2302C JMTJ2302C				
33.0mΩ		JMTL3400L			
38.0mΩ		JMTL3406A			
39.0mΩ			JMTL400N04A		
42.0mΩ		JMTL3402A			
61.0mΩ*	JMTL2302B				
100.0mΩ				JMTL2310A JMTM2310A#	
115.0mΩ					JMTJ11DN10A
126.0mΩ					JMSL10130AM#
131.0mΩ					JMSL10130AL
175.0mΩ*	JMTL3134K				
286.0mΩ					JMTL3N10A
2200.0mΩ				JMTL2N7002KS	

^{* -} $R_{\scriptscriptstyle DSON_MAX}$ based on $V_{\scriptscriptstyle GS}$ =4.5V

TO-220 Through-hole Package



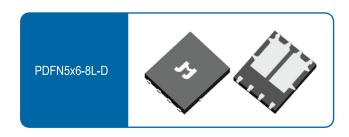
R _{dson_max} @V _{gs} =10V / V _{ds}	30V (I _p : 190A)	40V (I _D : 190A)	60V (I _o : 195A)	100V (I _D : 258~270A)
2.2mΩ				JMSH1001NC
2.6mΩ		JMTC025N04D		
2.7mΩ	JMTC018N03A			
2.9mΩ				JMSH1002NC
4.4mΩ			JMSH0602PC	

^{# -} SOT-23-6L

R _{DSON_MAX} @ V _{GS} =10V / V _{DS}	30V (I _p : 90~150A)	40V (I _D : 60~150A)	60V (I _D : 58∼180A)	100V (I _p : 26~219A)	150V (I _D : 61~200A)	200V (I _p : 129~135A)
3.3mΩ	JMTC3003A					
3.6mΩ				JMSH1003NC		
4.0mΩ		JMTC035N04A		JMSH1002YC		
4.3mΩ			JMTC035N06D			
4.5mΩ		JMTC4004A				
4.8mΩ					JMSH1504NC	
4.9mΩ				JMSH1004NC		
5.0mΩ	JMTC3005A					
5.3mΩ				JMSH1005PC		
6.0mΩ			JMTC060N06A			
6.2mΩ					JMSH1507PC	
6.3mΩ			JMSL0606PC			
7.0mΩ			JMTC80N06A			
7.7mΩ		JMTC60N04B				
7.8mΩ				JMSL1009PC JMSH1006PC JMSH1006ACR		
8.0mΩ				JMSH1008PC		
10.0mΩ			JMTC58N06B			
10.3mΩ				JMSH1010PC		
11.7mΩ						JMSH2010PC
13.7mΩ					JMSH1516PC	
19.0mΩ				JMSH1018PC		
20.0mΩ				JMTC170N10A		
32.0mΩ				JMTC320N10A		
36.0mΩ				JMSL1040AC		

Dual N-channel industrial-grade MOSFETs

PDFN 5x6 SMD Package



R _{dson_max} @V _{gs} = 10V / V _{ds}	30V (l _p : 37A)	40V (I _D : 43~64A)	60V (l _p : 19.3~59A)	100V (I _p : 4.5~48A)
5.5mΩ			JMSL0606PGD	
5.8mΩ			JMSH0606PGD	
6.5mΩ		JMSH0406PGD		
6.9mΩ		JMSL0406PGD		
7.8mΩ			JMSL0606PGD	
8.2mΩ		JMTG062N04D		
9.5mΩ	JMSL0315PGD			
9.6mΩ		JMTG080N04D		
10.6mΩ			JMSL0610PGD	
12.0mΩ			JMTG100N06D	
13.0mΩ				JMSL1013PGD
13.5mΩ			JMSL1013PGD	
21.0mΩ				JMSL1018PGD
23.0mΩ			JMSL0620PGD	
28.0mΩ			JMSL0630PGD	
36.0mΩ				JMSL104380GD
124.0mΩ				JMSL10130PGD
295.0mΩ				JMTG28DN10D

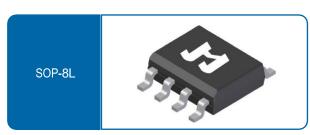
PDFN 3x3 SMD Package



R _{dson_max} @V _{gs} = 10V / V _{ds}	30V (I _p : 15~36A)	60V (I _D : 24A)
11.0mΩ	JMSL0315PUD	
11.8mΩ	JMTQ075N03D	
13.5mΩ	JMTQ3010D	
13.8mΩ		JMSL0615PUD
14.3mΩ	JMTQ120N03D	

R _{DSON_MAX} @V _{GS} = 10V / V _{DS}	30V (I _p : 12A)	40V (I _D : 12~20A)	100V (I _p : 10.1~17A)
19.2mΩ		JMTQ130N04D	
21.6mΩ	JMTQ240N03D		
26.0mΩ		JMTQ230N04D	
39.0mΩ			JMSL10380UD
125.0mΩ			JMSL10130PUD

SOP-8 SMD Package



R _{DSON_MAX} @V _{GS} = 10V / V _{DS}	20V (I _D : 6~6.5A)	60V (I _D : 8~12.4A)	40V (I _p : 13A)	60V (I _D : 5~11A)	100V (I _D : 2.4A)
10.3mΩ				JMSL0609PPD	
12.0mΩ		JMTP3010D JMSL0315PPD			
12.5mΩ			JMTP080N04D		
13.5mΩ				JMSL0608PPD	
14.0mΩ				JMTP110N06D	
15.0mΩ				JMSL0615PPD	
17.5mΩ*	JMTP9926A				
20.0mΩ		JMTP240N03D			
20.4mΩ				JMTP170N06D	
$23.0 m\Omega$		JMTP260N03D			
27.0mΩ*	JMTP9926B				
38.0mΩ				JMTP330N06D	
139.0mΩ					JMSL10130PPD

Single P-channel industrial-grade MOSFETs

PDFN 3x3 SMD Package

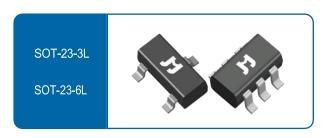


R _{dson_max} @V _{gs} = 10V / V _{ds}	-20V (I _p : -55A)	-30V (I _D : -45A)
7.3mΩ		JMTQ080P03A
8.3mΩ*	JMTQ55P02A	

^{* -} R_{DSON_MAX} based on V_{GS} =-4.5V (continued)

R _{DSON_MAX} @V _{GS} = 10V / V _{DS}	-30V (I _p : -12~-40A)	-40V (I _p : -8~-30A)	-60V (I _p : -22A)	-100V (I _p :-26A)
9.4mΩ	JMTQ100P03A			
10.8mΩ	JMTQ4407A			
13.0mΩ		JMTQ130P04A		
14.0mΩ	JMTQ160P03A			
20.0mΩ	JMTQ200P03A			
43.0mΩ		JMTQ440P04A		
50.0mΩ			JMPL0648AU	JMPL1050AU

SOT-23 SMD Package



R _{dson_max} @V _{gs} =	-12V	-20V	-30V	-40V
10V / V _{DS}	(I _D : -4.1~-7A)	(I _D : -2~-7A)	(I _D : -4~-4.2A)	(I _D : -5A)
24.5mΩ*		JMTJ210P02A		
26.0mΩ*		JMTJ250P02A		
27.0mΩ*	JMTJ2333A			
36.0mΩ*	JMTL2305B			
38.0mΩ*		JMTJ3415KL		
39.0mΩ*		JMTM3415KL#		
40.0mΩ*		JMTL3415KL		
42.0mΩ*		JMTL2305A		
47.0mΩ			JMTL3401A JMTJ3401A	
55.0mΩ			JMTL3407A	
60.0mΩ			JMTJ3407A	
62.0mΩ			JMTL3401B	
64.0mΩ			JMTJ3401B	
70.0mΩ*		JMTL2301C		
85.0mΩ				JMTM850P04A#
88.0mΩ				JMTL850P04A
104.0mΩ*		JMTL2301B		
125.0mΩ*		JMTL2301E		

^{* -} $R_{\rm DSON_MAX}$ based on $V_{\rm GS}$ =-4.5V

^{# -} SOT-23-6L

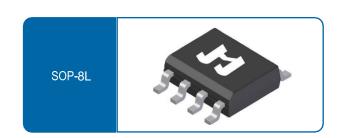
DPAK SMD Package



R _{DSON_MAX} @V _{GS} = 10V / V _{DS}	-20V (I _D : -60A)	-30V (I _p : -20~-100A)	-40V (I _p : -10~-70A)	-60V (I _p : -23~-46A)	-100V (I _p : -30~-46A)
5.3mΩ		JMTK050P03A			
6.4mΩ		JMTK060P03A			
7.5mΩ		JMTK080P03A			
8.5mΩ*	JMTK50P02A				
9.2mΩ			JMTK085P04A		
10.0mΩ		JMTK100P03A			
11.0mΩ		JMTK50P03A			
13.0mΩ			JMTK130P04A		
14.0mΩ		JMTK160P03A			
25.0mΩ				JMPL0622AK	
28.0mΩ					JMPL1025AK
34.0mΩ		JMTK340P03A			
39.0mΩ			JMTK440P04A		
50.0mΩ				JMPL0648AK	JMPL1050AK

^{* -} $R_{\rm DSON_MAX}$ based on $V_{\rm GS}$ =-4.5V

SOP-8 SMD package



R _{DSON_MAX} @V _{GS} = 10V / V _{DS}	-20V (I _D : -15A)	-30V (I₀: -5.1~-15A)	-40V (I _D : -5~-12A)	-100V (I _p : -6.3A)
9.0mΩ	JMTP085P02A	JMTP080P03A		
14.0mΩ		JMTP4407A		
14.3mΩ			JMTP130P04A	
16.5mΩ		JMTP4407B		
23.0mΩ		JMTP4435A		
25.0mΩ		JMTP250P03A		
35.0mΩ		JMTP340P03A		
47.0mΩ			JMTP440P04A	
50.0mΩ				JMPL1050AP
51.0mΩ			JMTP520P04A	
55.0mΩ		JMTP9435A		
85.0mΩ			JMTP850P04A	

Industrial-grade MOSFETs with $400V \le V_{DS_MIN} \le 1kV$

There exist two technology platforms in the design of high-voltage MOSFETs: planar, SJ (super-junction). The latter is further divided into two device structures: multi-layer epitaxy, deep trench.

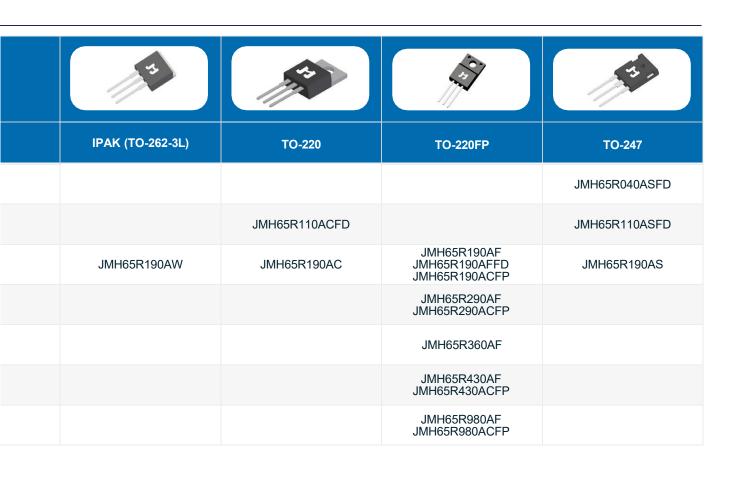
For battery charging, DC-DC voltage switching including power inverting, AC or DC motor driving, and other high-voltage applications, JJM offers the following high-voltage MOSFETs to meet the diverse needs of system designers. These MOSFETs are designed in either planar or SJ technology platform.

Superjunction 650V MOSFETs

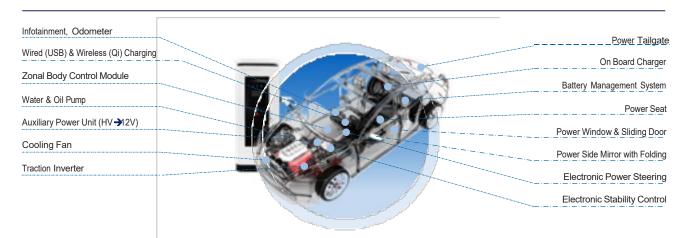
Package	*		F	
	DFN8080-4L (8x8 mm)	DPAK (TO-252-3L)	D2PAK (TO-263-3L)	
40mΩ (I _D =71A)				
110mΩ (I _D =32~35A)	JMH65R110APLNFD		JMH65R110AEFD	
190mΩ (I _D =17.4~20A)	JMH65R190APLN JMH65R190APLNFD		JMH65R190AE	
290mΩ (I _D =10~12A)	JMH65R290APLN		JMH65R290AE	
360mΩ (I _D =10.3~11A)		JMH65R360AK		
430mΩ (I _D =10.4~11.2A)	JMH65R430APLN	JMH65R430AK	JMH65R430AE	
980mΩ (I _D =4A)	JMH65R980APLN	JMH65R980AK		

Planar 650V MOSFETs

Package		470mΩ (I _D =20A)	580mΩ (I _D =16A)	
	DPAK (TO-252-3L)			
	TO-220	JMPC20N65BJ	JMPC16N65BJ	
	TO-220FP	JMPF20N65BJ	JMPF16N65BJ	



740 mΩ (\mathbf{I}_{D} =12A)	950m Ω (I_D =10A)	1,350mΩ (I _D =7A)	$2,640 \text{m}\Omega \ (I_D=4A)$
		JMPK7N65BJ	JMPK4N65BJ
JMPC12N65BJ	JMPC10N65BJ	JMPC7N65BJ	JMPC4N65BJ
JMPF12N65BJ	JMPF10N65BJ	JMPF7N65BJ	JMPF4N65BJ



The shift from brushed to brushless motors, the proliferation of LEDs to replace the filament-type light bulbs in lightings, the increasing use of DC motors to improve fuel efficiency, the adoption of more IA (artificial intelligence) technology in driver assistance (e.g. blind-spot warning, lane departure warning, lane keeping assist, adaptive cruise control, etc.) result in the use of more and more power semiconductor components in vehicles. In alignment to the mega trend of electrification of transportation & mobility, JJMICROELECTRONICS (a.k.a. JJM®) has been offering more and more automotive-grade components to E-mobility (battery storage, renewable energy source, electric propulsion) accent & exterior lightings, ADAS (advanced driver assistant systems), vehicle-to-vehicle communications & cybersecurity, telematics and infotainment, etc.

In the auto-grade MOSFETs which bear 'Q' as the last letter in the product name, the die is designed with key performance matrices {ONresistance RDS(ON), input capacitance CISS, total gate charge Qg} minimized and SOA (safe operating area) further optimized. Assembled in the thermally efficient low-profile packages like the TOLL-compatible PowerJE®10x12 and PDFN5x6-8L with long protruded lead pins, these autograde MOSFETs offer world-class power efficiency, lower operating temperature, exceptional long-term reliability despite of the hostile working environment typical inside and outside of automobiles.

At JJM, the auto-grade diodes (TVS, ESD, rectifier, zener, etc.) are constructed with the patented clip assembly process. Compared to the traditional A+B structure, the risk of cold joint is minimized, thermal and physical stress on the die surface are minimized. All these result in outstanding long-term component reliability. Long-standing and reliable protection to prevent the semiconductor devices (application processor, mixed-signal interface IC, etc.) used in key sub-systems like power and traction inverter from damage by spurious electrical surges and other hazard are achieved. These auto-grade diodes offer world-class electrical performance like clamping voltage tailored to specific application requirement, low leakage current, and fast response as well as compliance to AEC-Q101-Rev-E stress test standards.

Roadmap for Industrial and Automotive Packages



- Auto-grade power semiconductor components (MOSFET, TVS) from JJM are being extensively applied to motor driving in the many sub-systems in automobiles: EPS (electronic power steering), oil pumps, water pumps, power windows, rear trunk / hatch, power seats, power sunroofs, etc.
- Auto-grade MOSFETs offer outstanding performance matrices {ON-resistance RDS(ON), input capacitance CISS, total gate charge Qg} with the SOA (safe operating area) further optimized. Assembled in the thermally efficient low-profile packages like the TOLL-compatible PowerJE®10x12, and the PDFN5x6-8L with long protruded lead pins, these power-efficient auto-grade MOSFETs are widely applied in various applications inside automobiles. The long-term reliability are ensured by their compliance to the AEC-Q101- Rev-E stress test standards.
- Assembled in the patented DO-218 package of JJM, the auto-grade TVS (transient voltage suppressor) can be applied to both 12VDC and 24VDC systems. They were tested to pass ISO 16750-2 P5a/5b compliant load-dump test and off PPP_Max performance of 4.6 ~ 8kW. Besides the ability to perform consistently across all key electrical matrices, these TVS also offer high surge immunity and exceptional long-term operating reliability. Hence, these auto-grade TVS are field-proven to be indispensable for the protection of valuable electronic sub-systems inside automobiles.

Components Recommended: Auto-grade MOSFETs

Product Name	JJM Package	Config- uration	V _{DS} _ Max (V)	I _D _Max (A)	V _{GS(th)} Typ (V)	R _{DS(ON)_Typ} @ V _{GS} = 10V (mΩ)	$R_{DS(ON)_Max}$ @ V_{GS} = 10V (m Ω)	V _{GS Max} (V)	E _{AS Max} (mJ)	C _{iss Typ} (pF)	Q _{q Tvp} (nC)
JMSH0401PGQ	PDFN5x6-8L	N	40	276	2.8	0.9	1.1	±20	441	5280	68
JMSH0401PTLQ	PowerJE®10x12	N	40	337	2.8	1	1.25	±20	317	5280	68
JMSL0402MGQ	PDFN5x6-8L	N	40	198	1.6	1.3	1.7	±20	194	3125	47
JMSL0402MGQ	PDFN5x6-8L	N	40	183	1.6	1.6	2	±20	163	3133	46
JMSH0403PGQ	PDFN5x6-8L	N	40	121	2.8	2.7	3.4	±20	216	1542	22
JMSL0406PGQ	PDFN5x6-8L	N	40	90	1.6	4.2	5.2	±20	36	1204	17.9
JMSL04060GDQ	PDFN5x6-8L-D	N+N	40	49	1.6	5.5	6.9	±20	36	1227	17.9
JMSH060SPGQ	PDFN5x6-8L	N	60	314	2.8	1	1.3	±20	1014	7219	102
JMSH0602MGQ	PDFN5x6-8L	N	60	225	2.8	1.3	1.7	±20	375	5874	81
JMSH0603PGQ	PDFN5x6-8L	N	60	168	2.8	1.9	2.4	±20	240	3562	50
JMSH0606PGDQ	PDFN5x6-8L-D	N+N	60	56	2.8	4.7	5.8	±20	216	1492	34

Components Recommended: Auto-grade TVS

7.1	Product Name		ISO16750-2 P5A	V _{R_Max}	@I _R	v	BR	@I _τ	V _{C_Max}	@ l _{pp}
Uni- Polar	Bi- Polar	Package	Test Pulse: 10 times	(V)	(mA)	Min (V)	Max (V)	(mA)	(v)	A
SM8S22A-AL	SM8S22CA-AL	DO-218AB	US: 101V/1Ω/400ms	22	5	24.4	26.9	5	35.5	186
SM8S24A-AL	SM8S24CA-AL	DO-218AB	US: 101V/1Ω/400ms	24	5	26.7	29.5	5	38.9	170
SM8S30A-AL	SM8S30CA-AL	DO-218AB	US: 202V/4Ω/350ms	30	5	33.3	36.8	5	48.4	136
SM8S33A-AL	SM8S33CA-AL	DO-218AB	US: 202V/4Ω/350ms	33	5	36.7	40.6	5	53.3	124
SM8S36A-AL	SM8S36CA-AL	DO-218AB	US: 202V/4Ω/350ms	36	5	40.0	44.2	5	58.1	114
SM6P22A	SM6P22C	SMC	US: 87V/2Ω/150ms	22	5	24.4	26.9	5	35.5	141
SM6P24A	SM6P24C	SMC	US: 87V/2Ω/150ms	24	5	26.7	29.5	5	38.9	129
SM6P30A	SM6P30C	SMC	US: 151V/8Ω/150ms	30	5	33.3	36.8	5	48.4	103
SM6P33A	SM6P33C	SMC	US: 151V/8Ω/150ms	33	5	36.7	40.6	5	53.3	94
SM6P36A	SM6P36C	SMC	US: 151V/8Ω/150ms	36	5	40	44.2	5	58.1	86

Power Sourcing (Lightings incl.) in Automobiles





- Auto-grade power semiconductor components (MOSFET, TVS) from JJM are being extensively applied to power sourcing applications (accent lights, head lamp, incl.) in automobiles.
- Partly attributed by the advanced wafer process, the auto-grade MOSFETs offer excellent electrical characteristics such as RDS(ON) and Qg. The resultant low switching and conduction loss significantly reduce operating temperature hence they are good fit for the power conversion circuits running at high frequency to minimize BOM (bill of materials) space. The portfolio of auto-grade MOSFETs currently cover V_{DS,MIN} from 40 ~ 150V (medium-voltage category). Future releases shall be extended all the way to 650V and higher.
- The auto-grade TVS are assembled with the patented clip assembly process. Compared to the traditional A+B structure, the risk of cold joint is minimized, thermal and physical stress on the die surface are minimized, high degree of long-term operating reliability are resulted. On top, the excellent voltage clamping ability, low leakage current and fast response are typical of these auto-grade TVS. Compliance to the AEC-Q101-Rev-E stress test standards provide another further warranty to trustable operation.

Components Recommended: Auto-grade MOSFETs

Product Name	JJM Package	Config- uration	V _{DS} _ Max (V)	I _{D Max} (A)	V _{GS(th) Typ} (V)	R _{DS(ON) Typ} @ V _{GS} = 10V (mΩ)	R _{DS(ON) Max} @ V _{GS} = 10V (mΩ)	V _{GS Max} (V)	E _{AS Max} (mJ)	C _{iss Typ} (pF)	Q _{я Тур} (nC)
JMSL06063UQ	PDFN3x3-8L	N	60	44	1.6	7.5	9.4	±20	34	1087	16.6
JMSL0610PGDQ	PDFN5x6-8L-D	N+N	60	38	1.6	8.5	10.6	±20	34	1087	16.6
JMSL0612PGQ	PDFN5x6-8L	N	60	52	1.6	9.5	12	±20	20	731	13.9
JMSL0612PKQ	TO-252-3L	N	60	57	1.7	9.9	12	±20	58	734	13.1
JMSL0620PGQ	PDFN5x6-8L	N	60	32	1.8	16	20	±20	26	409	7.5
JMSL0620PGDQ	PDFN5x6-8L-D	N+N	60	23	1.8	18	23	±20	26	409	7.5
JMSL1006PGQ	PDFN5x6-8L	N	100	110	1.8	4.7	5.9	±20	110	2604	42
JMSL1008PGQ	PDFN5x6-8L	N	100	88	1.8	6	7.6	±20	102	2200	34
JMSL1010PKQ	TO-252-3L	N	100	86	1.9	8.3	10	±20	94	1535	26
JMSL1010PUQ	PDFN3x3-8L	N	100	46	1.9	8.5	10.6	±20	45	1535	26
JMSL1018PGQ	PDFN5x6-8L	N	100	47	1.8	15	18.7	±20	29	769	12.7
JMSH1504PTLQ	PowerJE®10x12	N	150	227	3.2	3.3	4.2	±20	800	6540	88
JMSH1507PEQ	TO-263-3L	N	150	161	3.2	5.2	6.5	±20	540	4320	68
JMSH1509PGQ	PDFN5x6-8L	N	150	87	3.2	8.5	9.9	±20	331	2181	30
JMSH1535PGQ	PDFN5x6-8L	N	150	29	3.3	27	35	±20	48	760	12.3

Components Recommended: Auto-grade TVS

	oduct ame		P _{PP}	V _{R_Max}	@ I _R	V _{BR} (V)		@I _τ	V _{C_Max}	@ l _{pp}
Uni- Polar	Bi- Polar	Package -	(W)	(V)	(μΑ)	Min	Max	(mA)	(V)	A
SMBJ22A-AU	SMBJ22CA-AU	SMB	600	22	1	24.4	26.9	1	35.5	16.9
SMBJ24A-AU	SMBJ24CA-AU	SMB	600	24	1	26.7	29.5	1	38.9	15.4
SMBJ26A-AU	SMBJ26CA-AU	SMB	600	26	1	28.9	31.9	1	42.1	14.3
SMBJ30A-AU	SMBJ30CA-AU	SMB	600	30	1	33.3	36.8	1	48.4	12.4
SMBJ33A-AU	SMBJ33CA-AU	SMB	600	33	1	36.7	40.6	1	53.3	11.3
10BJ22A-AU	10BJ22CA-AU	SMB	1,000	22	1	24.4	26.9	1	35.5	28.2
10BJ24A-AU	10BJ24CA-AU	SMB	1,000	24	1	26.7	29.5	1	38.9	25.7
10BJ26A-AU	10BJ26CA-AU	SMB	1,000	26	1	28.9	31.9	1	42.1	23.8
10BJ30A-AU	10BJ30CA-AU	SMB	1,000	30	1	33.3	36.8	1	48.4	20.7
10BJ33A-AU	10BJ33CA-AU	SMB	1,000	33	1	36.7	40.6	1	53.3	18.8
15BJ22A-AU	15BJ22CA-AU	SMB	1,500	22	1	24.4	26.9	1	35.5	42.3
15BJ24A-AU	15BJ24CA-AU	SMB	1,500	24	1	26.7	29.5	1	38.9	38.6
15BJ26A-AU	15BJ26CA-AU	SMB	1,500	26	1	28.9	31.9	1	42.1	35.6
15BJ30A-AU	15BJ30CA-AU	SMB	1,500	30	1	33.3	36.8	1	48.4	31.0
15BJ33A-AU	15BJ33CA-AU	SMB	1,500	33	1	36.7	40.6	1	53.3	28.2

Battery Management (BMS) in Automobiles



- Auto-grade power semiconductor components (MOSFET, TVS) from JJM manifest unique benefits to battery management system whose behavior is critical to NEVs (new energy vehicles).
- JJM offers auto-grade MOSFETs with ON-resistance as low as 0.56 mΩ which contribute to lower operating temperature. Assembled in state-of-the-art packaging process, the resulted power discrete component perfectly customer demands for the often conflicting requirement of high power and low heat dissipation. To name a few, auto-grade MOSFETs housed in the PDFN5x6-8L, PowerJE®7x8 (compatible with sTOLL), PowerJE®10 x12 (compatible with TOLL) offer some of the best class-leading performance in the industry. In addition, these components undergo the rigorous AEC-Q101-REV-E compliant stress tests, hence they are field proven to meet the challenge of harsh operating conditions typical of automobiles.
- The auto-grade TVS are manufactured with the patented clip assembly process. As opposed to the traditional A+B assembly, cold joint is minimized, die stress is much reduced, outstanding long-term reliability is achieved. These components achieve excellent peak pulse power P_{PP_Max} at 1kW and more in the minuscule SMB package size. Both uni-directional-bi-directional type of protection capabilities are available. Overall, the excellent electrical performance, the outstanding voltage clamping ability, the low leakage current, the fast response to incoming spurious voltage surges, and the compliance to AEC-Q101-Rev-E stress test standards make these auto-grade TVS from JJM a perfect answer to the ever demanding safety and reliability requirement upon the tens of millions of vehicles purchased by consumers nowadays.

Components Recommended: Auto-grade MOSFETs

Product Name	JJM Package	Config- uration	V _{DS} _Max (V)	I _{D_Мах} (A)	V _{GS(th)_Typ} (V)	R _{DS(ON)_Typ} @ V _{GS} = 10V (mΩ)	R _{DS(ON)_Max} @ V _{GS} = 10V (mΩ)	V _{GS_Max} (V)	E _{AS_Max} (mJ)	C _{iss_Typ} (pF)	Q _{g_Typ} (nC)
JMSH0401PTLQ	PowerJE®10x12	N	40	337	2.8	1	1.25	±20	317	5280	68
JMSH0401PTSQ	PowerJE®7x8	N	40	352	2.8	0.9	1.1	±20	441	5214	66
JMSL0402MGQ	PDFN5x6-8L	N	40	198	1.6	1.3	1.7	±20	194	3125	47
JMSH0402PKQ	TO-252-3L	N	40	170	2.8	2	2.5	±20	194	3020	41
JMSL0402MGQ	PDFN5x6-8L	N	40	183	1.6	1.6	2	±20	163	3133	46
JMSH0403PGQ	PDFN5x6-8L	N	40	121	2.8	2.7	3.4	±20	216	1542	22
JMSH0403PGHWQ	PDF- N5x6-8L-HW	N+N	40	111	2.8	2.7	3.3	±20	182	1715	25
JMSL0403PGQ	PDFN5x6-8L	N	40	128	1.5	2.5	3.1	±20	79	1424	22
JMSH0406PGDQ	PDFN5x6-8L-D	N+N	40	68	2.8	5.2	6.5	±20	96	1027	14.9
JMSL0406PUQ	PDFN3x3-8L	N	40	57	1.6	4.5	5.6	±20	36	1204	17.9
JMSH0406PUQ	PDFN3x3-8L	N	40	59	2.8	4.8	6	±20	96	1032	15.4
JMSL0406PKQ	TO-252-3L	N	40	78	1.6	4.7	5.6	±20	36	1204	17.9
JMSH0406PKQ	TO-252-3L	N	40	73	2.8	5	6.2	±20	96	1027	15.2
JMSH0406PGQ	PDFN5x6-8L	N	40	90	2.8	4.1	5.1	±20	96	1027	14.9
JMSL0406PGQ	PDFN5x6-8L	N	40	90	1.6	4.2	5.2	±20	36	1204	17.9

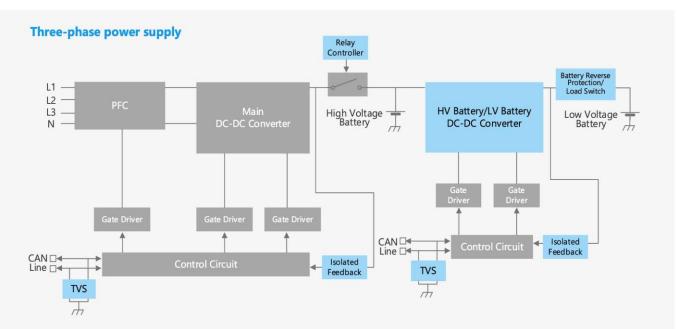
Components Recommended: Auto-grade TVS

	oduct ame	B . I	P _{PP}	V _{R_Max}	@ I _R	V _{BR} (V)		@ I _T	V _{C_Max}	@ I _{pp}
Uni- Polar	Bi- Polar	Package ·	(W)	(V)	(mA)	Min	Max	(mA)	(V)	А
SMBJ22A-AU	SMBJ22CA-AU	SMB	600	22	1	24.4	26.9	1	35.5	16.9
SMBJ24A-AU	SMBJ24CA-AU	SMB	600	24	1	26.7	29.5	1	38.9	15.4
SMBJ26A-AU	SMBJ26CA-AU	SMB	600	26	1	28.9	31.9	1	42.1	14.3
SMBJ30A-AU	SMBJ30CA-AU	SMB	600	30	1	33.3	36.8	1	48.4	12.4
SMBJ33A-AU	SMBJ33CA-AU	SMB	600	33	1	36.7	40.6	1	53.3	11.3

NEV (new energy vehicle) Charging Station operate in similar fashion as the fuel dispensers in typical gas station. They are either secured to the ground or wall-mounted. Nowadays, charging station are commonly installed in public establishments (government & commercial buildings, shopping malls, restaurants, banks, hotels, underground & ground-level parking lots, etc.) and private properties (1/2-car attached garages, parking lots, etc.) in residential area to refill the battery energy depleted at standard / fast speed depending on the capability of the charging and the receiving ends. The input of charging station is directly connected to the provincial / national electric power grid while the output end is equipped with a bulky charging plug with AC / DC output voltage level.



Today, many NEV charging station provide more than one charging plug with VAC output to facilitate standard (7 \sim 22kW) to rapid (CCS type for 50 \sim 350kW). In comparison, the CHAdeMO type charging plug provides VDC output at 25 \sim 100kW. The typical 'slow' charging station is designed to output VAC in either single-phase or three-phase to provide charging rate at 7 / 22 / 40 kW. This is converted into DC voltage by the OBC (on-board charger) inside the NEV to recharge the on-board battery storage. Such 'slow' charger is generally installed in residential & commercial parking lots. Charging station with VDC output (also known as 'off-board charger') directly re-charge the on-board battery storage without the OBC. Such charging station are typically designed to support high charging rate at 60 / 120 / 200 kW or more



The AC power from the grid are fed into the OBC of an NEV through the charging station. The OBC converts VAC to VDC in order to re-charge the on-board battery storage, typically through some kind of distribution box. On the other hand, charging station with VDC output embeds inside a number of AC-to-DC power modules connected in series & parallel configuration. In view of the commercial offerings in the market, there exist 3 major trends: 1) multiple output levels with each at a constant power rating; 2) multiple output voltages with each at a constant charging current; 3) multiple high-power modules connected in series & parallel configuration.

In charging station with VDC output, there are two key power stages. The PFC (power factor correction) stage maintains the phase relationship between input current and voltage. As a result, the total harmonic distortion (THD) cast upon the current in the AC power grid are significantly reduced. The reactive power dissipated are minimized and the overall energy efficiency are improved.

In charging station with VDC output, the second key power stage is the DC-DC up-inverter. This takes the DC-level output from the PFC stage and converts it to the voltage level required for battery charging. The output voltage and current of the up-inverter vary over time depending on the overall health and charge level of the on-board battery storage.

JJM offers a wide range of automotive-grade power discrete semiconductor components to suit the PFC and DC-DC up-inverter (primary-side and secondary-side rectification) power stages. These include, rectifier bridges, FRED (fast recovery epitaxy diode), TVS (transient voltage suppressor), ESD protection for the CAN communication port, low-VF schottky rectifiers, and power MOSFETs.

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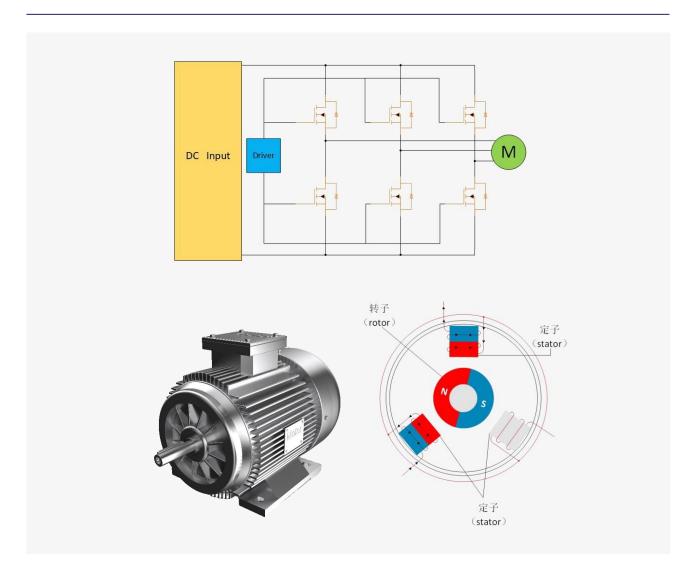
Components Recommended: Auto-grade Epitaxial Fast Recovery Rectifiers

Product Name	I _{F(AV)_Max} (A)	V _{RRM_Max} (V)	I _{FSM_Max} (A)	I _{FSM_Max} (A)	I _{R_Max} (mA)	Q _{r_Max} (nC)	t _{rr_Max} (ns)	JJM Package
JECR3006SL	30.0	600	270	2.8	5.0	50.0	22	TO-247J-2L
JECR6006SL	60.0	600	600	2.4	5.0	74.0	50	TO-247J-2L

Components Recommended: Auto-grade ESD over CAN Ports

Product Name	Direction	V _{RRM_Max} (V)	V _{BR Min} (V)	V _{c_Max} (V)	@ I _{PP} (A)	I r_Max (mA)	P _{PP_Max} (W)	V _{ESD-Air} (kV)	V _{ESD-Contact} (kV)	С _{Ј_Тур} (рF)	JJM Package
JEB24T2BH	Bi-dir	24.0	26.7	60.0	6	1.00	350	±30	±30	15	SOT-23





Motor based on the BLDC (brush-less direct current) overcomes the congenital defect of brushed DC motor, in which the mechanical commutators are replaced by electronic commutators. As such, BLDC motor offers the benefit of easy speed adjustment of the brushed DC motor as well as the simple structure of typical AC motor. On top, BLDC motor does not create high-voltage sparks when the direction of rotation is changed, operates reliably, and is easy to maintain. Because electronic inverter is used to convert the direct current input into alternating current to drive the respective stator coils, BLDC motor is effectively a three-phase PMAC (permanent magnet synchronous AC motor) with sensor output to tell the rotor position.

The MOSFETs from JJMICROELECTRONICS (a.k.a. JJM®) are being extensively used in motor driving within power tools, fans, electric bicycles, garden tools, vacuum cleaners, electric fans. They exhibit the following properties.

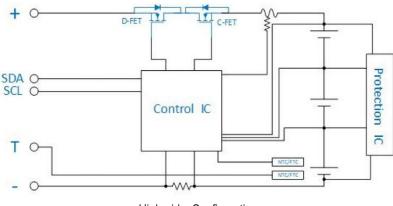
- Outstanding ON-resistance R DS(ON) to minimize the operating temperature and conduction loss, strong avalanche performance EAS to sustain high surge without damage (e.g. JMTG035N04A)
- **04** Assembled in highly thermal efficient power packages like PDFN3x3/5x6-8L, DFN2020-6L, TO-220/247/251/252/263- 3L, SOP-8L, SOT-23, SOT-23-3/6L, etc.
- **02** Exceptional input gate charge Qg hence low switching loss and the ability to support high switching frequency. All these allow the operating temperature to be reduced and better longterm reliability to be achieved
- **05** All electrical parameters exhibit negligible lot-to-lot variation and good long-term reliability
- $\hline V_{DS_MIN} \ \ ranges \ from \ 30V \ to \ 200V, \ R_{DS(ON)} \ is \ as \ low \ as \ 0.55m\Omega \ (e.g. \\ JMSL030SAG) \ and \ 0.56m\Omega \ (e.g. \ JMSL040SAG), \ FOM \ is \ as \ low \ as \ 47$
- Complete product portfolio to meet the diversified requirement on performance requirement, price expectation, and application space constraint, etc.

Depending on the breakdown voltage VBR(DSS)_MIN requirement, JJM offers $V_{DS_MIN} = 30 \sim 100V$ Trench & SGT MOSFETs based on trench or SGT technology platform from 30V to 200V for motor driving under various application environment. System engineers simply select the right MOSFETs based on output power and peak/average current requirement.

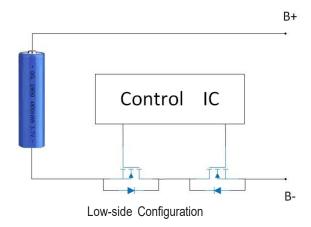
Components Recommended: MOSFETs

11.1 ~ 21.0V (3 ~ 5 cells in series)			29.4V s in series)		· 36.0V s in series)	> 36V (> 9 cells in series) ≥80V			
		40	V	6	0 V				
Product Name									
JMSL030STG	JMTG3002B	JMSL040SPG	JMSL0403AG	JMSL0601TG	JMTG060N06A	JMSH0803MG	JMSH1003NG		
JMSL0301TG	JMTG3003A	JMSL0401PG	JMTG4004A	JMSL0601TG	JMTK060N06A	JMSL0803MG	JMSL1004RG		
JMSL0302PG	JMTG040N03A	JMSL0401TG	JMTK4004A	JMSL0602MG	JMTK80N06A	JMSH0804NG	JMSH1006PG		
JMSL0302PG	JMTG3005A	JMSL0402PG	JMTK4005A	JMSL0603PG	JMTE035N06D	JMSH0803AGS	JMSH1008PG		
JMSL0303TG	JMTK3002B	JMSL0402TG	JMSL0406AK	JMSL0606PG	JMTG070N06A	JMSH0805PG			
JMTK3003A	JMTK3004A		JMTG035N04A		JMTG100N06A				
JMTK3005A	JMTK3006B								





High-side Configuration



With our everyday livings being more harmonized with green environment and surrounded by increasingly IA (artificial intelligence) injected merchandise, battery packs based on different chemicals have become part of our digital lifestyle. They exist, in various forms & sizes, inside smart phones, wearables, laptops, electronic toys, robot vacuum cleaners, E-bikes, power tools, UAVs (unmanned aerial vehicles), robots, power banks, portable energy storage, NEVs (new energy vehicles) and the traditional ICE (internal combustion engine) based vehicles. BMS (Battery management system) is instrumental to how well the battery pack operates and how reliable the operation is. In typical operation, BMS first collects the state of charge of the battery pack, analyze the loading and subsequently exchange the key information with the relevant sub-systems outside of the battery pack. Along the way, BMS has to make balance act upon all the units inside the battery pack, determine if any of the units is to be shut down, or be re-charged at a specific rate, or continue to release its stored energy at a specific rate. All these decision must be made depending on the real-time condition inside and outside of the battery pack, while safety must be ensured at all time.

Regardless of the type of materials used in each renewable battery cell, BMS is a system capable of real-time monitoring and management of battery pack. The electrical properties of each battery cell is monitored in real time, diagnosis of the state of charge is subsequently carried out, warning are given and action are taken whenever appropriate, charging/pre-charge/discharge and charge-balancing are executed in accordance to the operating environment like thermal condition. Key objectives are: protect the battery cells from hazardous damage, improve the health of the individual battery cells, ensure the safe operation of the aggregated battery pack.

Why is BMS needed?

01 Safe operation of the battery pack: Over-discharge may cause permanent damage to battery cells. Over-heated and over-charged battery cells may cause unexpected rupture and subsequent explosion.

02 Functional requirements: During operation, it is necessary to know the capacity of the energy stored in the battery pack in real time. Load / Charge balancing must be vigorously taken care of in order to maintain the good health of the battery pack. BMS achieves these by carefully controlling the operating temperature.

The low / medium-voltage power MOSFETs from JJMICROELECTRONICS (a.k.a. JJM®) are extensively used for BMS in battery packs shipped within and outside of domestic China. They offer the following features and advantages.

- With the pitch size between two neighboring cells smaller than 1µm, die area of the MOSFET is optimized to achieve the best power density possible
- Low internal ON-resistance and input gate charge contribute to the excellent condition and switching losses of the MOSFETs
- Because of good consistency upon the ON/OFF threshold voltage level across all MOSFETs manufactured, bin management at FT stage is trivial, multiple MOSFETs can be connected in parallel to facilitate large output current without any of them being falsely turned ON
- All MOSFETs exhibit high UIS avalanche breakdown capability and are 100% screened for their UIS performance at the FT (final test) stage during production
- Because these MOSFETs are housed in packages with outstanding thermal properties (i.e. low thermal resistance), high level of continuous output current can be supported

For BMS application, JJM offers MOSFETs housed in different packages and with $V_{\text{DS MIN}}$ covering 30 ~ 200V. These components are based on either SGT or trench technology platform. System designers simply choose the right MOSFET based on the loading requirement (e.g. power rating of the motor being driven) and the output current needed.

Components Recommended: MOSFETs

Battery Voltage	11.1 ~ 21.0V (3 ~ 5 cells in series)		18.5 ~ (5 ~ 7 cells		25.9 ~ 36.0V (7 ~ 9 cells in series)	> 36V (> 9 cells in series)
MOSFET V _{DS}	30V		40	V	60V	≥80V
	JMSL030STG	JMTG018N03A	JMSL040SPG	JMSH0403TG	JMSL0606PK	JMSH0803ME
	JMSL0301TG	JMTG3002B		JMTG4004A	JMSL0606PE	JMSH0804NE
	JMSL0302PG	JMTG3003A	JMSL0401PG	JMTK4004A	JMTK060N06A	JMSH1003NE
MOSFET Typically	JMSL0303TG	JMTG040N03A	JMSL0401TG	JMTK4005A	JMTK80N06A	JMSH1004NE
Used at Output Terminals of BMS	JMSL0307PG	JMTG3005A	JMSL0402PG	JMSL0406AK	JMTK70N07A	JMSH1006PE
	JMTK3003A	JMTK3002B	JMSL0402TG	JMTG035N04A	JMTE035N06D	JMSH1008PE
	JMTK3005A	JMTK3004A			JMTK58N06B	
		JMTK3006B				
MOSFET	JMTL3401A	JMTP9435A	JMTL850P04A	JMTP520P04A		
Typically Used for Battery Charging	JMTP4953A	JMTP4435A	JMTP440P04A			

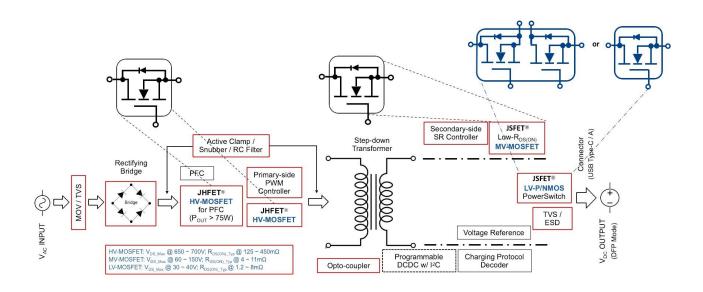
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Components Recommended: TVS

	oduct lame	V_{R_Max}	I _{R_Max} @VR	V _{BR_Min} @IT	V _{BR_Max} @IT	I _{T_Max}	V _{C_Max} @ IPP	I _{IPP_Max}
Uni- Polar	Bi- Polar	(V)	(μΑ)	(V)	(V)	(mA)	(V)	(A)
SMCJ5.0A	SMCJ5.0CA	5	300	6.4	7	10	9.2	163
SMCJ6.0A	SMCJ6.0CA	6	250	6.67	7.37	10	10.3	145.6
SMAJ5.0A	SMAJ5.0CA	5	120	6.4	7	10	9.2	43.5
SMAJ6.0A	SMAJ6.0C	6	120	6.67	7.37	10	10.3	38.8
SMBJ5.0A	SMBJ5.0CA	5	120	6.4	7	10	9.2	65.2
SMBJ6.0A	SMBJ6.0CA	6	120	6.67	7.37	10	10.3	58.3
SMDJ5.0A	SMDJ5.0CA	5	800	6.4	7	10	9.2	326.1
SMDJ6.0A	SMDJ6.0CA	6	800	6.67	7.37	10	10.3	291.3
5.0SMDJ11A	5.0SMDJ11CA	11	5	12.2	13.5	10	18.2	275
5.0SMDJ12A	5.0SMDJ12CA	12	5	13.3	14.7	10	19.9	252





In view of the latest effort by European Commission for universal chargers announced on Oct. 4, 2022, fast chargers equipped with USB-C® (EN IEC 62680-1-3:2021 Stds.) shall become a common scene from the end of CY2024. As far as the current state stands in Q4CY2022, fast chargers with output power ranging from 18W to 100W (even 120W or greater) and with one or more USB Type-A and Type-C output ports, which support fast charging protocols (USB PD3.0/3.1, USB BC1.2, UFCS T/TAF 083-2022, Qualcomm QCxx, MediaTek PExxx, Huawei S/FCP, Oppo D/FCP, Samsung AFC, Apple 2.4A, etc.) have already been proliferating among consumers who embrace digital life style and green energy. They are commonly used to re-charge the battery embedded in mobile AloT or EloT (artificial or edge internet-on-thing) products such as smartphones, tablets, smart watches, AWS earphones, and laptops. The more advanced design are equipped with 3rd-generation WBG (wide-band-gap) power semiconductor devices (gallium nitride D/E-mode HEMT). In spite of the physically compact size, they do not generate excessive high temperature that may cause hand injuries. On top, many of the world's top smartphone OEMs stop bundling chargers with their new generation of smartphones in recent years. This results in the hockey-stick effect such that these compact faster chargers have become mainstream in the market.

Flyback and LLC are the commonly used topologies in the AC/DC power conversion sub-system in the fast chargers. Flyback topology is frequently used in designs with output power less than 65W while LLC topology are typically found in fast chargers with output power of 90W and higher to meet the power efficiency required by the regulatory bodies in the world. Due to the relatively lower BOM cost that those of the LLC topology, ACF-Flyback topology is adopted by more and more medium-power designs. For example, it is favoured by many designs in which the 3rd-generation WBG (wide band-gap) GaN (gallium nitride) based HEMTs (high electron mobility transistor) are incorporated. Independent of the topology used, the internal block diagram of a typical fast charger is shown here.

JJMICROELECTRONICS (a.k.a. JJM®) offers a rich portfolio of discrete semiconductor components to the implementation of fast chargers. These include anti-surge MOV and TVS at the AC input end, FRD (fast recovery diodes) that suppress the voltage spikes caused by the transformer leakage, HV MOSFETs which perform the down conversion (high-voltage DC to low-voltage DC) and PFC (75W+ design) function in the primary-side, MV/LV MOSFETs for synchronous rectification and power-switching at the USB Type-A/C ports, ESD protection for the USB PD (power delivery) protocol decoder IC, etc.

Components Recommended for Primary-side: FRDs used in PFC

Product Name	Charger's O/P (W)	I _{F(AV)_Max} (A)	VRRM_Max (V)	FSM_Max (A)	V _{F Max} (V)	@ I _F (A)	I _{R Max} (m A)	C _{J Max} (pF)	t " Max (ns)	JJM Package
RS1010FL	20 ~ 65	1.0	1000	25	1.3	1.0	5.0	7.0	500	SOD-123FL
RS1MAF	20 ~ 65	1.0	1000	30	1.3	1.0	5.0	7.0	500	SMAF
RS3MB	90 ~ 120	3.0	1000	100	1.3	3.0	5.0	30.0	500	SMB
US5M	90 ~ 120	5.0	1000	125	1.7	5.0	5.0	35.0	75	SMC

Components Recommended for Secondary-side: ESD Protection over USB Type-A & Type-C Ports

Product Name	Pin(s) Protected	Direction	V _{RWM_Max} (V)	V _{BR_Min} (V)	V _{C_Max} (V)	@ I _{PP} (A)	I _{R_Max} (mA)	P _{PP_Max} (W)	V _{ESD-Air} (kV)	V _{ESD-Contact} (kV)	C _{J_Typ} (pF)	JJM Package
JEU24P3	\/DLIC	Uni-dir	24.0	26.0	35.0	200	0.50	5,100	±30	±30	750	DFN
JEU12N3	VBUS	Uni-dir	12.0	13.0	32.0	180	1.00	4.500	±30	±30	950	2x2-3L
JEU12T- 2BL	CC0/	Uni-dir	12.0	13.0	26.0	20	0.15	500	±30	±30	90	SOT23
US5M	CC1	Uni-dir	5.0	6.0	16.7	18	1.00	350	±15	±8	150	
JEB12C	D+ / D-	Bi-dir	12.0	13.3	30.0	12	1.00	350	±30	±30	1.0	SOD-
JEB03CX	D. / D-	Bi-dir	3.3	3.6	17.5	20	0.10	350	±30	±30	1.0	323

- At the primary-side of a typical AC-DC fast chargers, regardless of whether the HV MOSFETs or the fast proliferating GaN-based e-Mode HEMT is populated, JJM provides the HV SJ (super-junction) MOSFETs which is based on the advanced JHFET® technology platform for PFC switching. At the secondary-side, the MV/LV SGT (shielded-gate trench MOSFETs which is based on the advanced JSFET® technology platform provide reliable and high-efficiency operation for synchronous rectification and output current switches at the USB-C® port.
- The JHFET-based N-ch SJ MOSFETs at V^{PS_MIN} = 650V from JJM offer ON-resistance R^{DS(ON)} as low as 35 mΩ, Qg at down to 9.7 nC, C ^{iss} as small as 333 pF. All these SJ MOSFETs were tested to pass the UIS test during FT (final test) stage at the A/T (assembly & test) sites. The N-ch SGT MOSFETs which is based on the JSFET technology platform offer V_{DS MIN} at 30 ~ 200V.
- Their ON-resistance RDS(ON) are as low as 0.55 mΩ, Qg are at down to 2.3 nC, and FOM are as small as 47. Again, all these SGT MOSFETs were tested to pass the UIS test during FT stage at the A/T sites. With extremely low C_{iss}, C_{oss}, C_{rss} and Q_g and superior SOA (safe operation area), etc., these power semiconductor devices effectively address the challenges of soft/hard switching, spurious voltage spikes induced by inductive loadings, EMI, etc. Such outstanding static and dynamic electrical properties are attributed to the patented JSFET and JHFET technology platforms of JJM. Overall, the performance of these SGT and SJ MOSFETs are at world class levels.

Components Recommended for Primary-side: HV MOSFETs used in PFC and PWM Switching

Product Name	JJM Package	Compatible Industry- common Package	Plat- form	Configuration	V _{DS Max} (V)	I _{D Max} (A)	V _{GS(th)} Typ	
JMH65R190APLN	DFN8080-4L	-	SJ	N	650	17	3.5	
JMH65R190AF	TO-220FP-3L	-	SJ	N	650	20	3.5	
JMH65R290APLN	DFN8080-4L	-	SJ	N	650	10	3.5	
JMH65R290ACFP	TO-220FP-NL	-	SJ	N	650	12	3.5	
JMH65R430APLN	DFN8080-4L	-	SJ	N	650	10	3.5	
JMH65R430AF	TO-220FP-3L	-	SJ	N	650	11	3.5	
JMH65R430ACFP	TO-220FP-NL	-	SJ	N	650	11	3.5	
JMH65R430AK	TO-252-3L	DPAK	SJ	N	650	11	3.5	
JMH65R490AFFD	TO-220FP-3L	-	SJ	N	650	5	3.5	
JMH65R980AFFD	TO-220FP-3L	-	SJ	N	650	4	3.5	
JMH65R980AK	TO-252-3L	-	SJ	N	650	4	3.5	

Components Recommended for Secondary-side: MV MOSFETs used in Synchronous Rectification

Product Name	Package	Compatible Industry- common Package	V _{DS Max} (V)	I _{D Max} (A)	V _{GS(th) Typ}	R _{DS(ON) Typ} @ V _{GS} =10V (mΩ)	R _{DS(ON) Max} @ V _{GS} =10V (mΩ)	
JMSL0608PP	SOP-8L	SOP-8L	60	14	1.7	7.9	10.3	
JMSL0608PG	PDFN5x6-8L	SuperSO8	60	79	1.7	6.9	8.0	
JMSL1004RG	PDFN5x6-8L	SuperSO8	100	98	1.6	4.1	5.4	
JMSL1005PG	PDFN5x6-8L	SuperSO8	100	128	1.6	4.3	5.7	
JMSH1006PG	PDFN5x6-8L	SuperSO8	100	76	3.0	5.0	6.4	
JMSL1009PG	PDFN5x6-8L	SuperSO8	100	83	2.0	5.3	6.4	
JMSL1010PG	PDFN5x6-8L	SuperSO8	100	74	2.0	6.4	7.7	
JMSL1018PG	PDFN5x6-8L	SuperSO8	100	54	1.8	12.8	16.7	
JMSL1018AP	SOP-8L	SOP-8L	100	8	1.9	15.8	19.8	
JMSH1207AG	PDFN5x6-8L	SuperSO8	120	94	3.0	5.6	7.0	
JMSH1509PG	PDFN5x6-8L	SuperSO8	150	80	3.2	8.4	9.9	

R _{DS(OM Typ} @ V _{GS} =10V (mΩ)	R _{DS(ON) Max} @ V _{GS} =10V (mΩ)	V _{GS Max} (V)	C _{iss Typ} (pF)	Q _{a ™} (nC)	E _{as Max} (mJ)	FOM	Applicability
169	190	±20	1,560	38.0	405	6,422	for P _{OUT} > 100W
170	190	±20	1,560	38.0	405	6,460	for P _{out} > 100W
262	290	±20	1,056	22.0	281	5,764	for P _{out} ≤ 100W
260	290	±20	1,056	22.0	281	5,720	for P _{OUT} ≤ 100W
370	430	±20	703	18.4	180	6,808	for P _{OUT} ≤ 65W
364	430	±20	703	18.4	180	6,698	for P _{OUT} ≤ 65W
364	430	±20	703	18.4	180	6,698	for P _{OUT} ≤ 65W
370	430	±20	703	18.4	180	6,808	for P _{OUT} ≤ 65W
430	490	±20	677	20.0	180	8,600	for P _{OUT} ≤ 45W
895	980	±20	343	10.1	72	9,040	for P _{OUT} ≤ 20W
900	980	±20	333	9.7	80	8,730	for P _{OUT} ≤ 20W

VGS_Max (V)	Ciss_Typ (pF)	Qg_Typ (nC)	EAS_Max (mJ)	FOM	Applicability
±20	1,178	21.0	74	166	for P _{out} < 65W
±20	1,193	22.0	89	136	for P _{OUT} < 65W
±20	5,082	80.0	373	328	for P _{OUT} ≥ 100W
±20	4,892	77.0	402	331	for P _{OUT} ≥ 65W
±20	3,144	51.0	356	255	for P _{OUT} ≥ 65W
±20	2,420	43.0	216	228	for P _{OUT} < 65W
±20	1,959	36.0	96	230	for P _{OUT} < 65W
±20	969	18.0	74	230	for P _{OUT} < 65W
±20	769	12.7	24	201	for P _{out} < 65W
±20	2,208	35.0	135	196	for P _{OUT} ≥ 65W
±20	3,569	53.0	542	255	for P _{OUT} > 65W

Components Recommended for Secondary-side: LV/MV MOSFETs used in USB-C (DFPmode) output port for V_{BUS}

Product Name	JJM Package	Compatible Industry- common Package	Platform	Configuration	V _{DS_Max} (V)	I _{D_Max} (A)	V _{GS(th)_Typ} (V)	
JMTQ080P03A	PDFN3x3-8L	PQFN 3x3	Trench	Р	-30	-45	-1.5	
JMTQ100P03A	PDFN3x3-8L	PQFN 3x3	Trench	Р	-30	-40	-1.6	
JMSL0302AU	PDFN3x3-8L	PQFN 3x3	SGT	N	30	145	1.7	
JMSL0302BU	PDFN3x3-8L	PQFN 3x3	SGT	N	30	135	1.6	
JMSL0302BU	PDFN3x3-8L	PQFN 3x3	SGT	N	30	119	1.6	
JMSL0310AU	PDFN3x3-8L	PQFN 3x3	SGT	N	30	60	1.7	
JMSL0315AU	PDFN3x3-8L	PQFN 3x3	SGT	N	30	43	1.7	
JMSL0315AUD	PDFN3x3-8L-D	-	SGT	N + N	30	36	1.7	
JMSL0402AU	PDFN3x3-8L	PQFN 3x3	SGT	N	40	119	1.5	
JMSL0403PU	PDFN3x3-8L	PQFN 3x3	SGT	N	40	85	1.7	
JMSL0406PU	PDFN3x3-8L	PQFN 3x3	SGT	N	40	59	1.6	

JJM focuses on the end markets of consumer electronics, computing & peripherals, industrial, communication and automotive endsystems. In order to make sure that all the MOSFET produced meet the stringent requirement of the individual applications, JJM spent tremendous effort to study the markets and the needs of the customers. As a result, the electrical properties and performance of each JSFET / JHFET produced always deliver the best energy efficiency and long-term reliability without any compromise to cost-effectiveness. Because of the continual pursuit of compactness by consumers, chargers for mobile 3C (computing, communications, consumer electronics) products are getting smaller and smaller.

R _{DS(ON)_Typ} @ V _{os} =10V (mΩ)	R _{DS(ON)_Max} @ V _{GS} =10V (mΩ)	V _{GS_Max} (V)	C _{iss_Typ} (pF)	Q _{a_Typ} (nC)	E _{AS_Max} (mJ)	FOM	Applicability
5.8	7.3	±20	4,650	45.0	144	261	for I _{ou⊤} ≥ 3A
7.5	10.0	±20	3,564	37.0	121	278	for I _{OUT} < 3A
1.2	1.5	±20	2,975	39.0	101	47	for I _{OUT} ≥ 5A
1.5	1.9	±20	2,526	39.0	94	60	for I _{OUT} ≥ 5A
1.8	2.2	±20	2,091	39.0	61	58	for I _{out} ≥ 5A
4.0	5.0	±20	866	13.5	20	54	for I _{OUT} < 5A
7.0	8.8	±20	468	7.7	9	54	for I _{OUT} < 3A
8.8	11.0	±20	468	7.7	9	68	for I _{OUT} ≤ 2A
2.0	2.5	±20	2,131	36.0	126	72	for I _{OUT} ≤ 2A
1.9	2.5	±20	2,510	42.0	212	80	for I _{OUT} ≤ 5A
3.5	4.5	±20	1,474	27.0	36	95	for I _{OUT} < 5A

The limited application space inside the charger housing inevitably present a hostile operating environment, thus presenting a heavy toll on the long-term reliability and operation stability upon the power semiconductor devices used. JSFETs and JHFETs easily meet such demand at reasonable cost without any let-up in energy efficiency. JSFETs and JHFETs are available in packages like the low-profile PDFN3x3/5x6/8x8, and the legacy TO-220/247/251/252/263 & SOP-8, etc. The lead-frame, wire/ribbon/clip bonding, and epoxy materials used in the assembly of these MOSFETs are optimized to sustain high level of electrical stress to keep the thermal resistance low. Last but not the least, RoHS and halogen-free compliance are always standard with the MOSFETs from JJM.

100 Auto-grade 40~150V N-ch JSFET®

Increasingly Found Homes in Automobiles





Of these 100 auto-grade devices, the dies inside and the A/T were all produced at manufacturing sites certified for IATF 16949. All devices passed the AEC-Q101 compliant tests. Outstanding electrical characteristics like RDS(ON) of 0.56 \sim 57m Ω , Qg of 5.3 \sim 155.0nC, FOM of 55 \sim 354 ensure reliable operation in harsh operating environment.

In the thermally efficient SM-type PowerJE@10x12, PDFN3x3 / 5x6-8L/-D, TO-252/263-3/7L, materials used (lead frame, solder, epoxy, etc.) and the manufacturing steps (wire/clip bonding, die-attach, polyimide over die-top, etc.) are of MSL1 to minimize mechanical thermal stress. As such, stable operation over TJ = -55 \sim 175 °C are resulted. All devices shipped are halogen-free & RoHS-compliant.

Key Aspects of 40~150V Q-grade JSFET®

Parametric Performance to Meet the Challenge

Exceptional $R_{DS(ON)_Typ}$ at down to $0.56m\Omega$, FOM as small as 55, E_{AS_Max} as high as 1,634mJ lead to reliable operation under the harsh working environment typical of automobiles.

Parametric Performance to Meet the Challenge

All devices passed the stringent AEC-Q101 qualification @ 3 lots & T_J = 175°C. Wafer and A/T production facilities are IATF 16949 certified for quality management.

Unclamped Inductive Switching Tested

Fully UIS tested during production to confirm the device's ability to withstand the avalanche energy common in both resistive and inductive type of loads.

Robust & Thermal Efficient Packages

SM-type PowerJE®10x12, PDFN3x3/5x6-8L/-D, TO-252-3L, TO-263-3/7L with high immunity to thermal-mechanical stress enable reliable operation under excessively low / high ambient temperature

Market Applications

- O1 DC/DC boost for mini/LED backlighting in infotainment, LED driving in matrix headlights
- High/Low-side switching in POL DC/DC (e.g. HPC for automotive gateway & domain controller, SR rectification in OBC)
- Power stages for low / medium-power BLDC/DC motor driving in BCM (body control module) & fuel pump & EPS (electronic power steering), wireless charging
- **04** V^{BUS} power switch for USB PD 3.0/3.1 compatible DC output via USB Type-C $^{\circ}$ connectors
- 05 Load switching in various vehicle electrical systems of ICE-based and new-energy PHEV / BEV

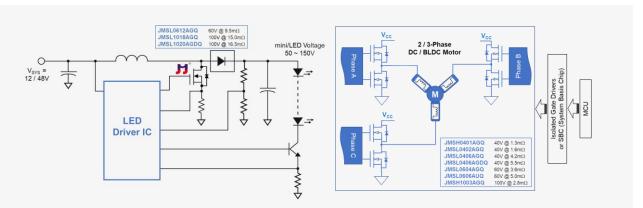
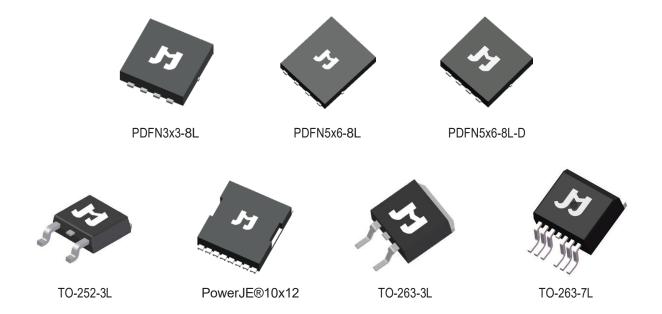


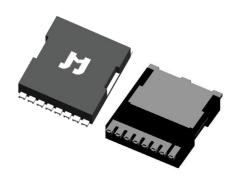
Figure 1: DC/DC Boost in mini/LED Backlighting

Figure 2: DC/BLDC Motor Driving

These 40 \sim 150V SGT MOSFETs are well suited for applications inside automobiles. Their long-term reliability were tested per AEC-Q101 quality standards. JMSL0406AGQ and its dual-die variant JMSL0406AGDQ are popular in body control module (BCM) for use cases like low-power DC motor driving. With $R_{DS(ON)}$ down to $1.3m\Omega$, JMSH041AGQ fits the power efficiency requirement of mid/high-power DC motors. Typical applications are: multi-way power seat, power tailgate, centralized door lock, ESC (electronic stability control). At $V_{DS_Max} = 100V$ and assembled in the low-profile PDFN5x6-8L package, JMSH0401AGQ is good for LED backlighting in flat panel display of the infotainment/ADAS unit. In contrast, JMSL1020AGDQ drives two strings of high-brightness LEDs simultaneously for backlighting in larger panel.



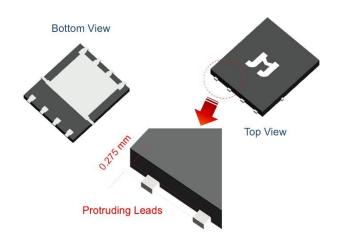
JJMICROELECTRONICS launched its start-of-the-art PowerJE[®] 10x12 Package and domestically leading SGT MOSFET



JJMICROELECTRONICS has independently developed the high-power, thin-package PowerJE® 10x12, now in large-scale mass production. while significantly antly reducing the f ootprint, it effectively improves the power density, thus suiting extremely compact terminal designs. Excellent thermal resistance contributes to better heat dissipation, which future guarantees the long-term reliability of devices.

Benchmark- ing	Company	Package	V _{DS_Max} (V)	$R_{DS(ON)_Typ} \ @V_{GS} = 10V \ (m\Omega)$	$R_{DS(ON)_Max}$ @ V_{GS} =10V (m Ω)	C _{iss} (pF)	Q _g (nC)	FOM
JMSL030SAG	JieJie Micro.	PDFN5x6-8L	30	0.55	0.69	7,543	120	66
BSx005N- 03Lxx	EU - Inxx	TDSON-8	30	0.48	0.55	8,900	122	59
NTxxx4C020N	US - Onxx	DFN5 5x6	30	0.56	0.67	10,144	139	78
PSxxx58- 30Yxx	CN - Nexx	LFPAK56E	30	0.54	0.67	6,912	114	62
CSx- 17570Q5B*	US - Texx	SON 5x6	30	0.56	0.69	10,400	185	104
Sixx90Axx	US - Vixx	PDFN5x6	30	0.62	0.78	9,120	130	81

In response to the increasing customer demand for performance and BOM (bill of material) space, JJM launched N-channel JSFET® series of JMSH1001ATL (V $_{\rm DS_MIN}$ = 100V) and JMSH1504ATL (V $_{\rm DS_MIN}$ = 150V) incorporating independent intellectual property rights; both are designed with advanced Power- JE $^{\circ}$ 10x12 package. When V_{cs} =10V, the measurements of $R_{\text{DS(ON)_Typ}}$ and FOM of the device are $1.3m\Omega$ / 202 (JMSH1001ATL) and 3.3 m Ω / 290 (JMSH1504ATL), respectively. When it comes to electrical properties, JMSH1001ATL outperforms the competition in China, and is not very different from similar products in Europe, the United States and Japan. Furthermore, the top-ranking linear model/safe operation area (SOA) feature enables devices to function in a safe and reliable manner even in the operating state of high current. The extremely low on-resistance helps improve operational efficiency, reduce system cost, and extend the service life of devices. Both products have extensive applications in power tools, light-duty electric vehicles, photovoltaic energy storage inverters, 5G communication and PoE++ and other terminals.



JJM: "Powered by the chips designed by the R&D team of JJM, manufactured by IATF 16949-certified fabs, and subjected to PowerJE® 10x12 assembly test on JJM' car-grade advanced package production lines, JMSH1001ATL's electrical properties are comparable to that of products of international firstline semiconductor IDM manufacturers, having contributed to the high-end breakthrough in the localization of like products. Featuring excellent thermal conductivity and low package parasitic inductance effect, this device is designed to handle up to 411A of current, thus being ideal for applications with stringent requirements for BOM (bill of material) space, electrical performance and long-term device reliability."

Both products are in mass production. Samples are available from JJM Sales Department, contract agents or related business channels. Information such as product specification and auxiliary system circuit design data such as POD (package outline drawing), simulation models H-Spice and P-Spice can be directly viewed or downloaded from the official website: https://www.jjm.com/promosfet1/



Through-Hole Packing Information

Packa	ge Name	Quantity (pcs)	CBM (cm³)
	Tube	80	53.6 x 2.0 x 0.54
TO-251-3L	Small box	4,000	55.5 x 16 x 4.8
	Carton box	20,000	55.5 x 33.5 x 21.5
	Tube	50	53.0 x 3.3 x 0.7
TO-220-3L	Small box	1,000	55 x 14 x 4.5
	Carton box	5,000	57 x 26 x 16
	Tube	50	53.0 x 3.3 x 0.7
TO-220AS-3L	Small box	1,000	55 x 14 x 4.5
	Carton box	5,000	57 x 26 x 16
	Tube	50	53.0 x 3.3 x 0.7
TO-220C-3L	Small box	1,000	55 x 14 x 4.5
	Carton box	5,000	57 x 26 x 16
	Tube	50	53.0 x 3.3 x 0.7
TO-220FP-3L	Small box	1,000	55 x 14 x 4.5
	Carton box	5,000	57 x 26 x 16
	Tube	50	53.0 x 3.3 x 0.7
TO-220FP-NL	Small box	1,000	55 x 14 x 4.5
	Carton box	5,000	57 x 26 x 16
	Tube	50	53.0 x 3.3 x 0.7
TO-262-3L	Small box	1,000	55 x 14 x 4.5
	Carton box	5,000	57 x 26 x 16
	Tube	30	53 x 4.1 x 0.75
TO-247-3L	Small box	450	52 x 13 x 5
	Carton box	2,250	55 x 28 x 18

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Package Na	ıme	Quantity (pcs)	CBM (cm³)
DFN1006-3L	Small box	100,000	21 x 21 x 21
	Carton box	400,000	45 x 45 x 24
DFN2020-6L	Small box	30,000	18.5 x 18.5 x 14
	Carton box	120,000	46 x 40 x 21
DFN3030-8L	Small box	10,000	36.6 x 34.1 x 5.4
	Carton box	50,000	37.5 x 30 x 35.5
	Small box	10,000	36.6 x 34.1 x 5.4
DFINOOOO-OL	Carton box	50,000	37.5 x 30 x 35.5
	Small box	4,000	36.6 x 34.1 x 5.4
DI NOUOU-4L	Carton box	20,000	37.5 x 30.0 x 35.5
DFN5060-8L	Small box	10,000	36.6 x 34.1 x 5.4
	Carton box	50,000	37.5 x 30.0 x 35.5
PDFN3x3-8L	Small box	10,000	36.6 x 34.1 x 5.4
	Carton box	50,000	37.5 x 30 x 35.5
PDFN3x3-8L-D	Small box	10,000	36.6 x 34.1 x 5.4
PDFN3X3-8L-D	Carton box	50,000	37.5 x 30 x 35.5
PDFN5x6-8L	Small box	10,000	36.6 x 34.1 x 5.4
PDFN3X0-0L	Carton box	50,000	37.5 x 30 x 35.5
PDFN5x6-8L-D	Small box	10,000	36.6 x 34.1 x 5.4
PDFN3X0-0L-D	Carton box	50,000	37.5 x 30 x 35.5
Dewer IF@7v0 (aTOLL)	Small box	4,000	36.6 x 34.1 x 5.4
PowerJE®7x8 (sTOLL)	Carton box	20,000	37.5 x 30 x 35.5
PowerJE®10x12 (TOLL)	Small box	2,000	36.6 x 34.1 x 5.4
FOWEIGE® TOX 12 (TOLL)	Carton box	10,000	37.5 x 30 x 35.5
SOT-23	Small box	30,000	21 x 21 x 21
301-23	Carton box	120,000	44 x 44 x 23

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SOT-23-3L	Small box	30,000	21 x 21 x 21
	Carton box	120,000	44 x 44 x 23
SOT-23-6L	Small box	30,000	21 x 21 x 21
	Carton box	120,000	44 x 44 x 23
SOT-89-3L	Small box	8,000	21 x 21 x 21
	Carton box	40,000	45.0 x 44.5 x 23.2
SOT-223-3L	Small box	8,000	35 x 34 x 5
	Carton box	40,000	36.5 x 36 x 25.5
SOT-323-3L	Small box	45,000	21 x 21 x 21
	Carton box	180,000	44 x 44 x 23
007.000.01	Small box	45,000	21 x 21 x 21
SOT-363-6L	Carton box	180,000	44 x 44 x 23
SOT-523-3L	Small box	30,000	21 x 21 x 21
	Carton box	180,000	44 x 44 x 23
0.07.700.01	Small box	45,000	21 x 21 x 21
SOT-723-3L	Carton box	180,000	44 x 44 x 23
	Small box	2,500	35 x 34 x 5
TO-252-3L	Carton box	5,000	36.5 x 36 x 25.5
	Small box	800	35 x 34 x 5
TO-263-3L	Carton box	4,000	36.5 x 36 x 25.5
TO 000 TI	Small box	800	35 x 34 x 5
TO-263-7L	Carton box	4,000	36.5 x 36 x 25.5
000.0	Small box	8,000	34 x 33 x 5.1
SOP-8	Carton box	48,000	37 x 37 x 36
TSSOP-8	Small box	10,000	34 x 33 x 5.1
	Carton box	60,000	37 x 37 x 36

Testing Specifications for Product Qualification

Industrial Grade

Test Item	Description	Test Conditions	Duration	DUT Quantity
PreCon	Pre-conditioning & IR Reflow (SMT-type DUTs only)	Bake-out for 24 hrs.: TA = 125°C; Moisture Soak: {MSL1 @ [TA = 85°C, RH = 85%] for 168 hrs.} or {MSL3 @ [TA = 30°C, RH = 60%] for 192 hrs.}; IR Reflow for 3 cycles: 1 cycle {preheat zone @ >185°C -> main heat zone @ 260 (+5/-0)°C for at least 30s} for t = 180s; JESD22-A113	Executed before the following tests: C-SAM (22 DUTs), TC, PC, H3TRB or HAST, IOL	330 Devices
HTRB	High Temperature Reverse Bias	T _J = 150°C Reverse Bias = Specification Limit x 100%; JESD22-A108	1,000 Hrs	77 Devices
НТСВ	High Temperature Gate Bias	T _J = 150°C Gate Bias = Specification Limit x 100%; JESD22-A108	1,000 Hrs	77 Devices
PC (AC)	Pressure Cooker (Auto-clave)	T _A = 121 ± 2°C; RH = 100%, P = 15psi; Bias = None; JESD22-A102	96 Hrs	77 Devices (pre-conditioned)
тс	Temperature Cycling	T _A = {[-55°C @ 15min.] <-> [150°C @ 15 min.]} per 1-hr cycle (air-to-air); Bias = None; JESD22-A104	1,000 Cycles	77 Devices (pre-conditioned)
H⁵TRB	High Humidity High Temperature Reverse Bias	T_A = 85°C; RH = 85%; 80% rated V_{DS_MAX} up to 100V; JESD22-A101	1,000 Hrs	77 Devices (pre-conditioned)
HAST	Highly Accelerated Temperature & Humidity Stress	$T_A = 130$ °C; RH = 85%; $V_{DS} = \pm 80$ % $V_{DS,MAX}$ up to 42V; P = 33.3 psi JESD22-A110	96 Hrs	77 Devices (pre-conditioned)
IOL	Intermittent Operating Life	TA = 25°C Devices powered to ensure △TJ > 100°C (not to exceed Absolute Maximum Rating) MIL-STD-750 M1037	15,000 Cycles	77 Devices (pre-conditioned)

Automotive Grade

Test Item	Description	Test Conditions	Duration	DUT Quantity
PreCon	Pre-conditioning & IR Reflow (SMT-type DUTs only)	Bake-out for 24 hrs.: TA = 125°C; Moisture Soak: {MSL1 @ [TA = 85°C, RH = 85%] for 168 hrs.} or {MSL3 @ [TA = 30°C, RH = 60%] for 192 hrs.}; IR Reflow for 3 cycles: 1 cycle {preheat zone @ >185°C -> main heat zone @ 260 (+5/-0)°C for at least 30s} for t = 180s; JESD22-A113	Executed prior to the following tests: C-SAM, TC, PC, H3TRB or HAST, IOL	3 Lots x 330 Devices
HTRB	High Temperature Reverse Bias	TJ = 175°C; Reverse Bias = Specification Limit x 100%; JESD22-A108	1,000 Hrs	3 Lots x 77 Devices
HTGB	High Temperature Gate Bias	TJ = 175°C; Reverse Bias = Specification Limit x 100%; JESD22-A108	1,000 Hrs	3 Lots x 77 Devices
PC (AC)	Pressure Cooker (Autoclave)	TA = 121 ± 2°C; RH = 100%, P = 15psi; Bias = None; JESD22-A102	96 Hrs	3 Lots x 77 Devices (pre-conditioned)
тс	Temperature Cycling	TA = {[-55°C @ 15min.] <-> [150°C @ 15min.]} per 1-hr cycle (air-to-air); Bias = None; JESD22-A104	1,000 Cycles	3 Lots x 77 Devices (pre-conditioned)
H³TRB	High Humidity High Temperature Reverse Bias	TA = 85°C; RH = 85%; 80% rated V _{DS_MAX} up to 100V; JESD22-A101	1,000 Hrs	77 Devices (pre-conditioned)
HAST	Highly Accelerated Temperature & Humidity Stress	TA = 130°C; RH = 85%; VDS = ±80% V _{DS_MAX} up to 42V; P = 33.3 psi JESD22-A110	96 Hrs	77 Devices (pre-conditioned)
IOL	Intermittent Operating Life	TA = 25°C Devices powered to ensure △TJ > 100°C (not to exceed Absolute Maximum Rating) MIL-STD-750 M1037	15,000 Cycles	77 Devices (pre-conditioned)